

Session 3: Monitoring and advanced diagnostics to enable AM fundamental understanding –

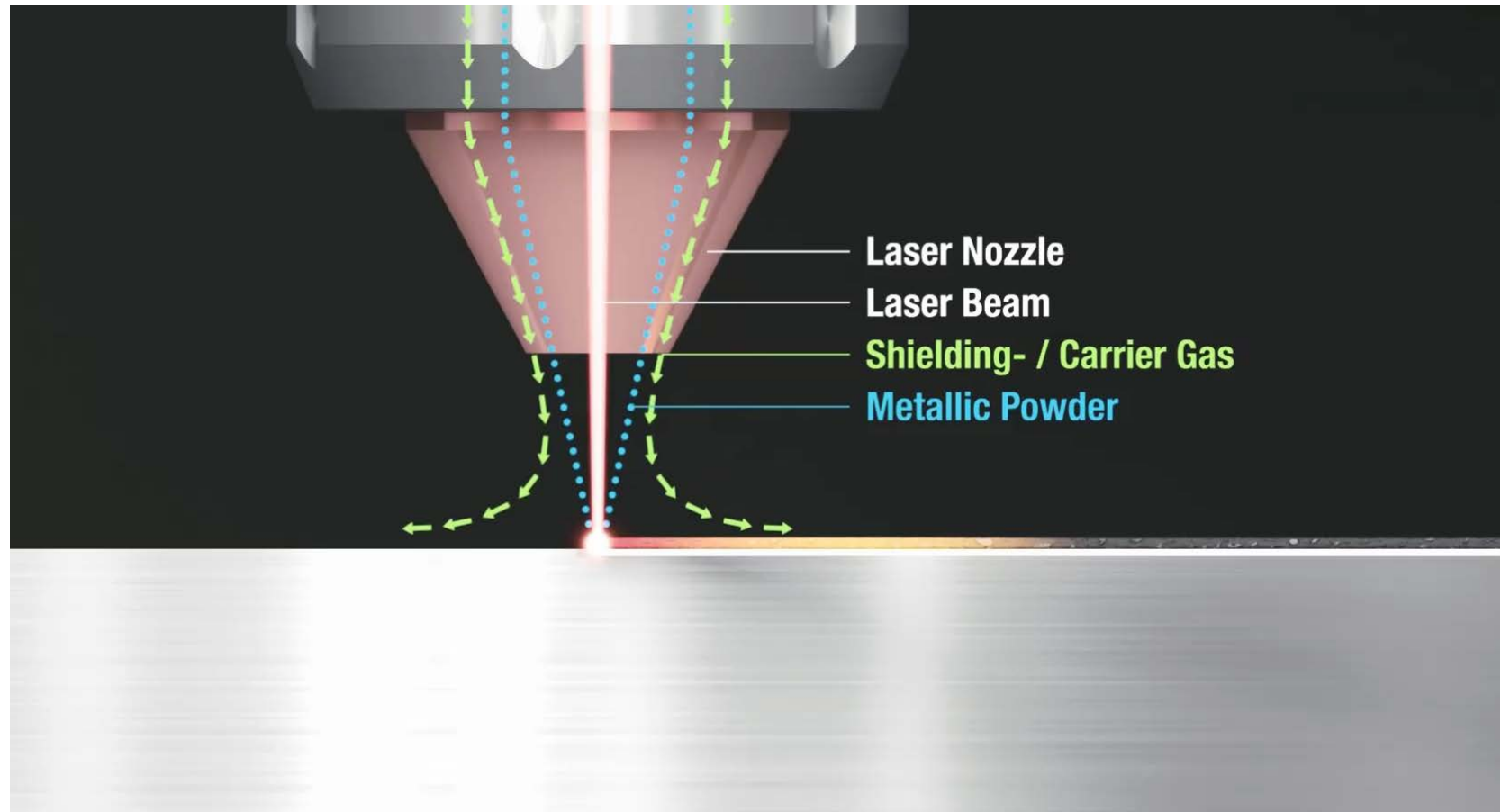
Direct Energy Deposition and Electrospinning

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**NORTHWESTERN
UNIVERSITY**



Hybrid Additive and Subtractive Machining



Prototypes and small series production of complex lightweight and integral parts for:

- 1) Die & Mold**
- 2) Aerospace**
- 3) Automotive**
- 4) Medical**

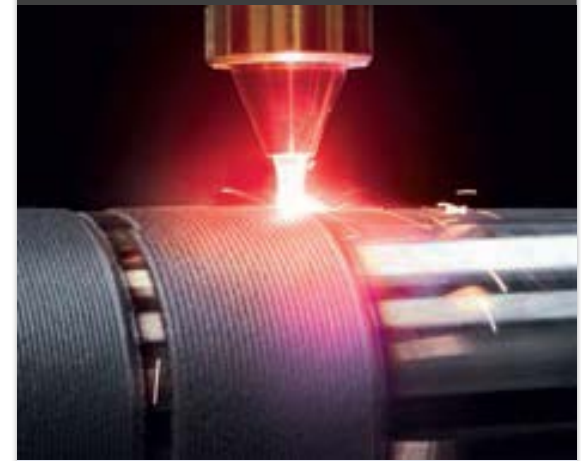
Repair of Turbine and Die & Mold Components



Repair of damaged and worn components for:

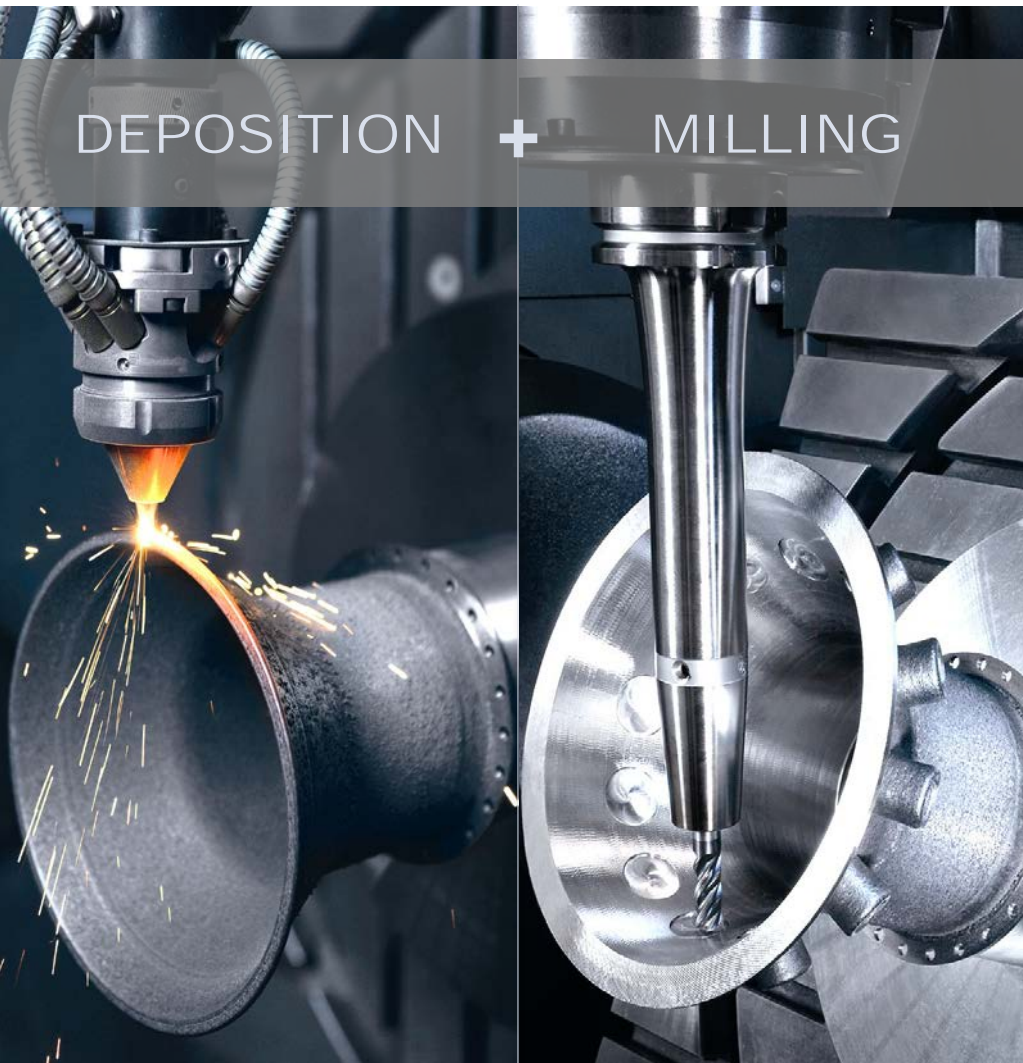
- 1) Medical**
- 2) Die & Mold**
- 3) Aerospace**
(e.g. Blade Tip Repair)

Corrosion and Wear Resistant Coatings

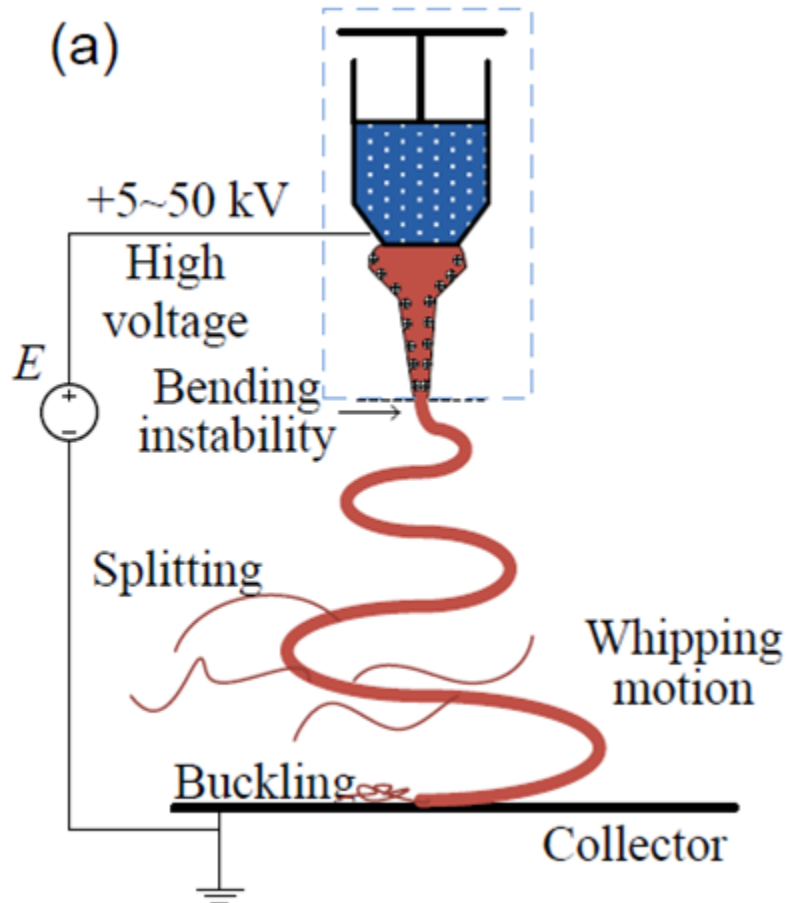


Partial coatings and complete part coatings (corrosion and wear resistant):

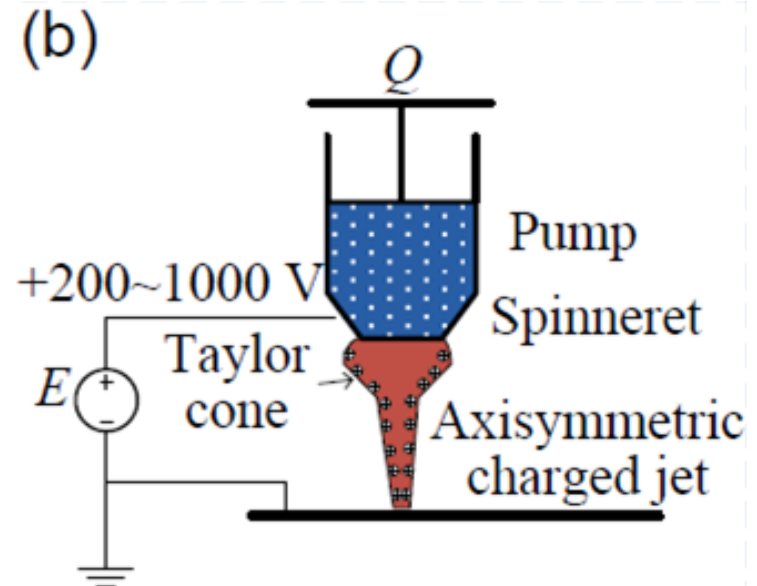
- 1) Mould Making**
- 2) Off Shore Drilling**
- 3) Machine Tool**
- 4) Medical**



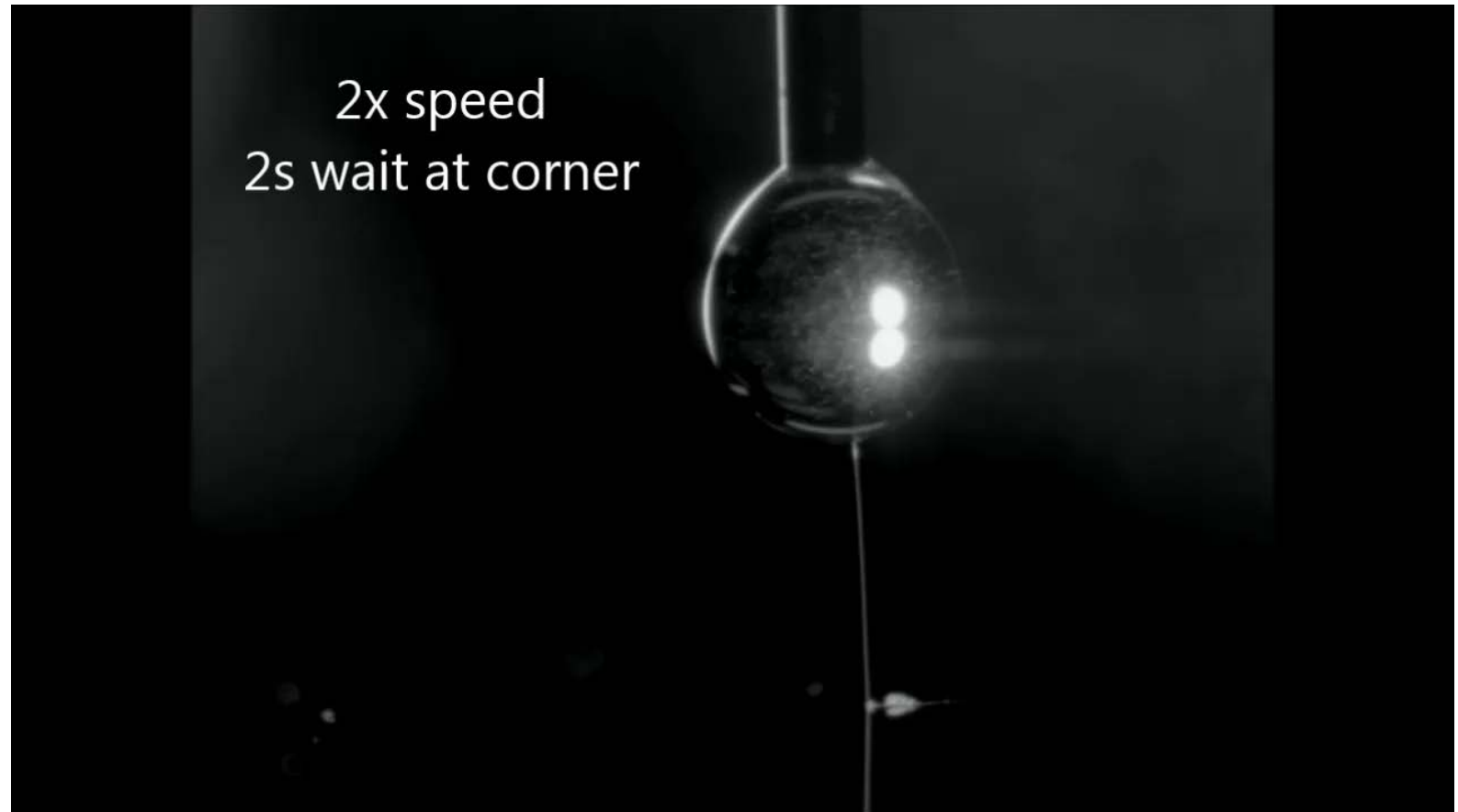
- **The flexibility of the additive manufacturing via laser powder nozzle is combined with the precision of the cutting technology**
- The workpiece can be built-up in several steps. Intermediate milling operations are possible.
- Machining of large, complete workpieces
- Repair of turbine components, repair in die & mold, technical and wear resistant coatings

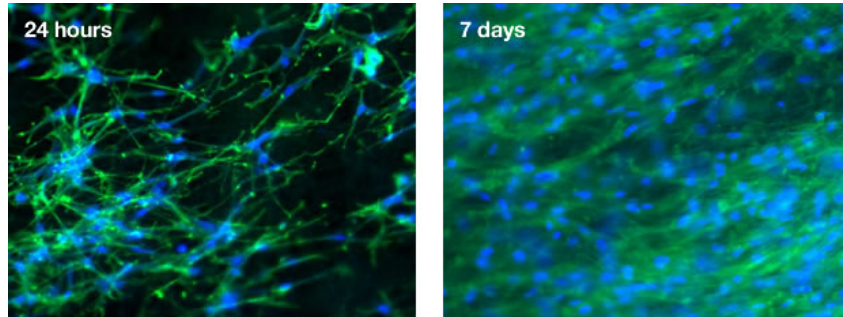


- Far Field Electrospinning – achieve fast deposition of nanofibers

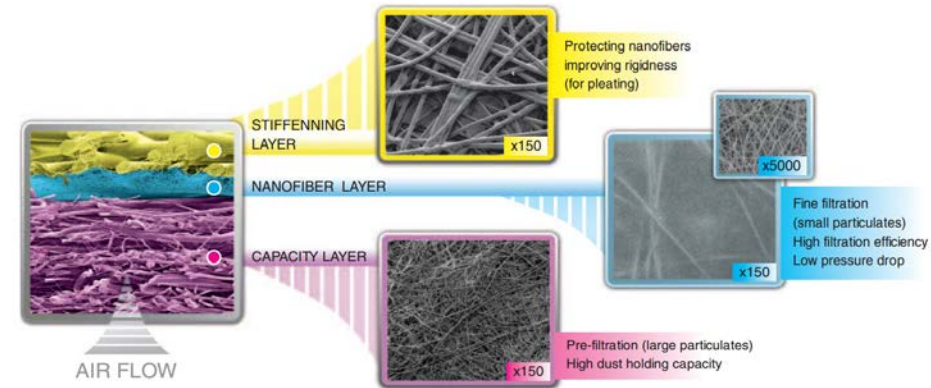


- Near Field Electrospinning takes a random deposition process and converts it into a controlled additive manufacturing process.

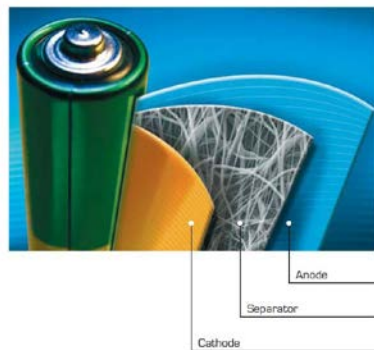




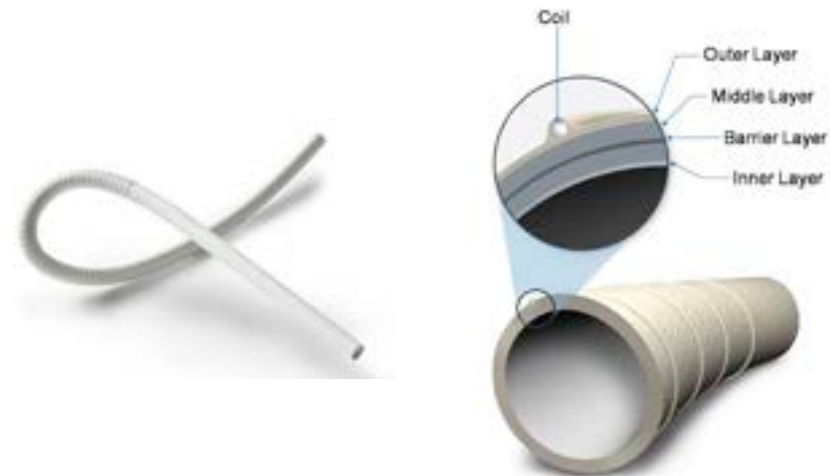
3D cell scaffolds for cell growth and drug testing. (Electrospinning Company)



Air Filters (Elmarco)

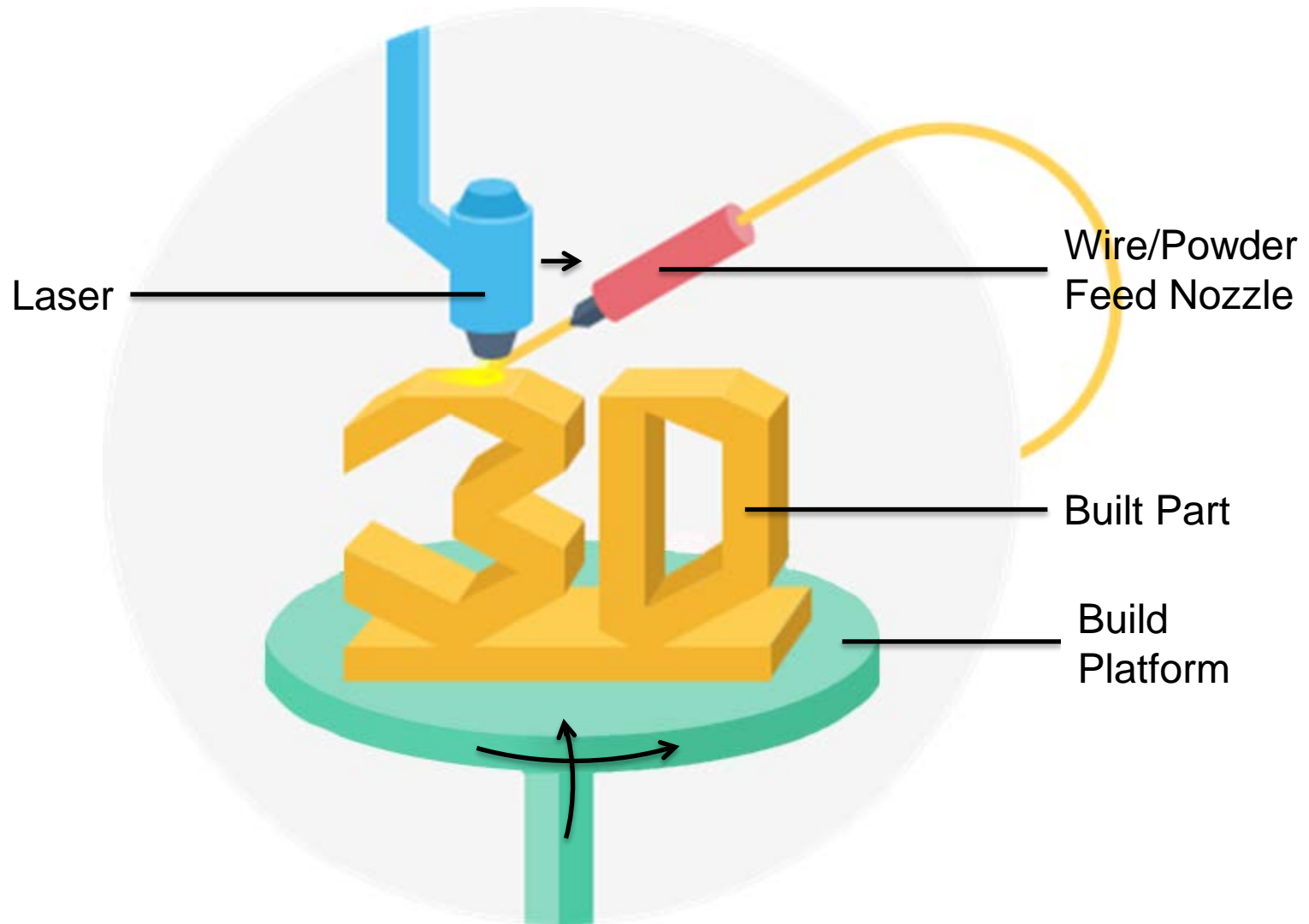


Battery Separators (Elmarco)



AVflo™ Vascular Access Grafts with multilayer structure (Nicast)

- **Overview of DED and Electrospinning**
- **Process Parameters and Their Influences**
- **Sensing and Characterization Methods**
- **Process Control**
- **Research Needs**





- **Powder Deposition Parameters**

- Powder Flow Rate
- Shield Gas Flow Rate
- Powder Shape/Size/Type
- Nozzle Type

- **Laser Parameters**

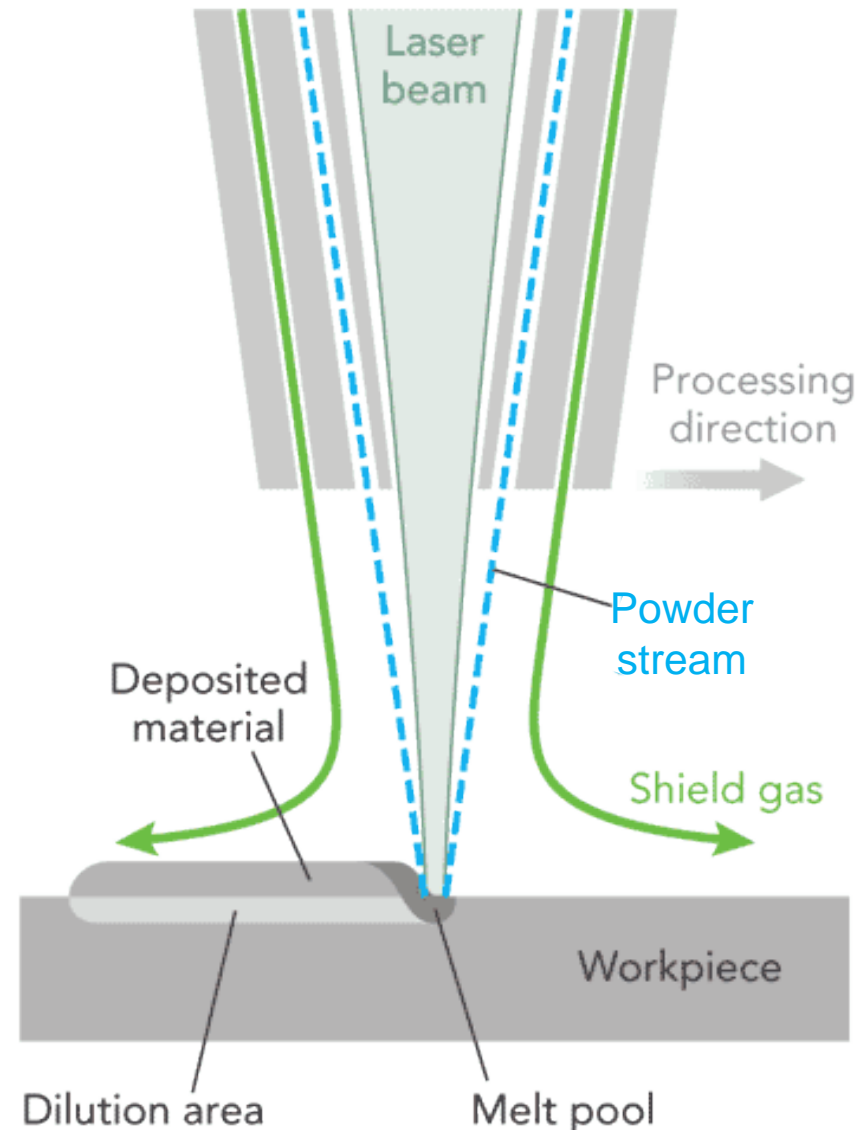
- Laser Spot Size
- Laser Scanning Speed
- Laser Power
- Laser Type

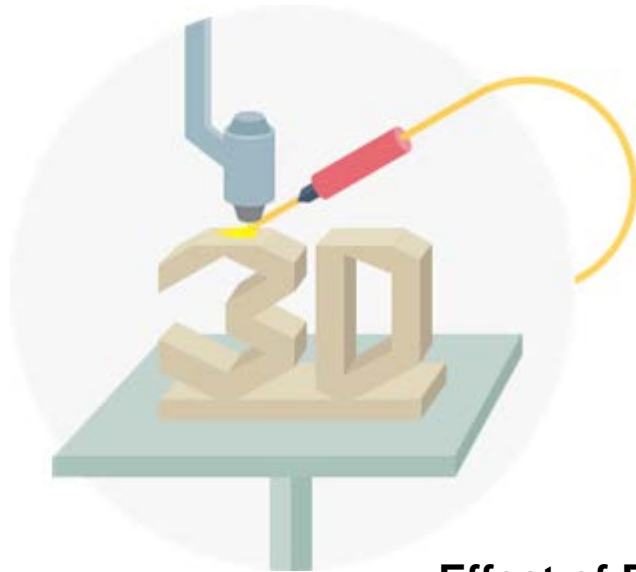
- **Geometric Parameters**

- Hatch Spacing
- Layer Height
- Build Geometry
- Build Strategy

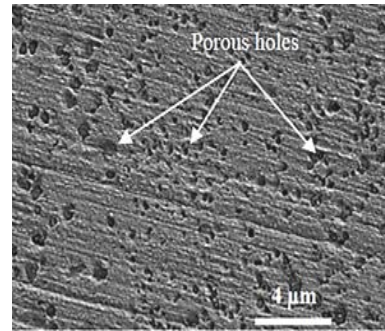
- **Substrate Parameters**

- Substrate Surface Condition
- Substrate Temperature
- Substrate Size

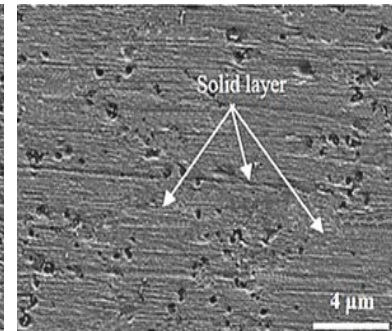




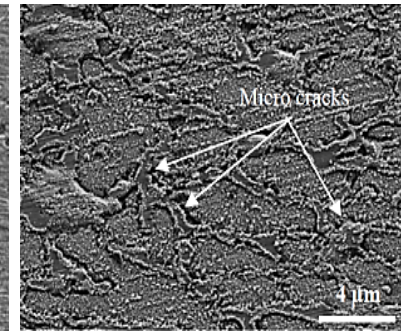
Effect of Powder Mass Flow Rate on Microstructure^[1]



0.8 g/min

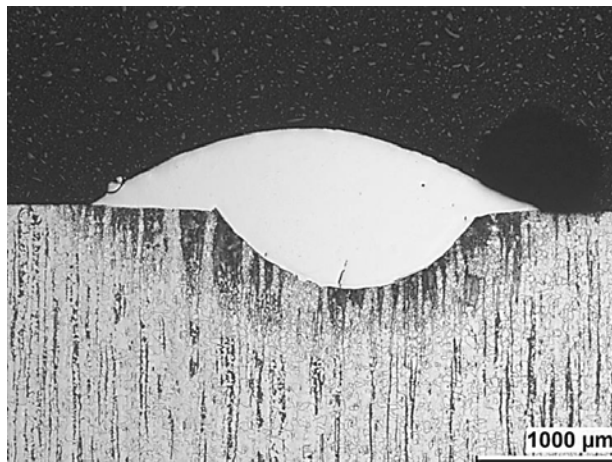


1.58 g/min

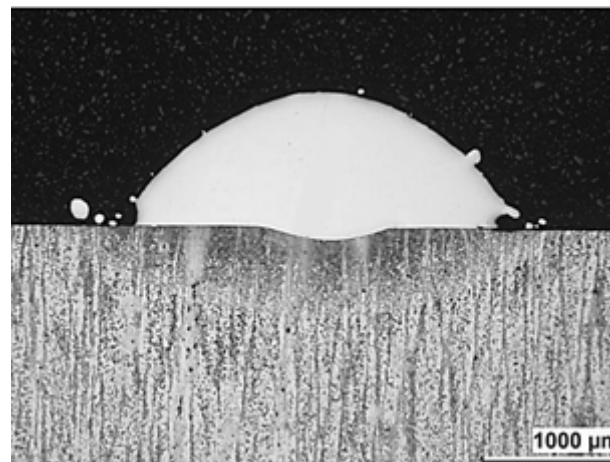


3.15 g/min

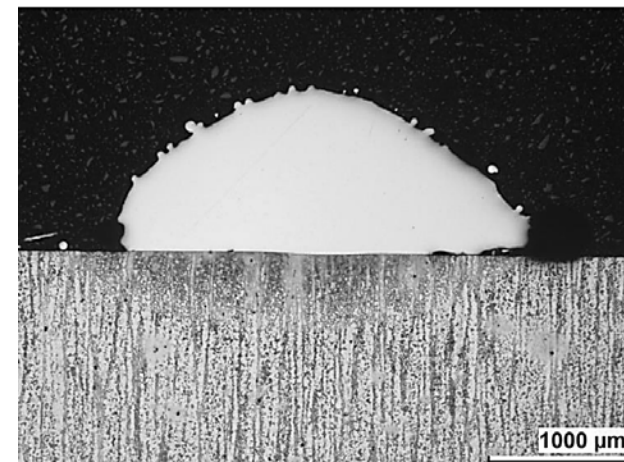
Effect of Powder Mass Flow Rate on Clad Quality^[2]



20 g/min



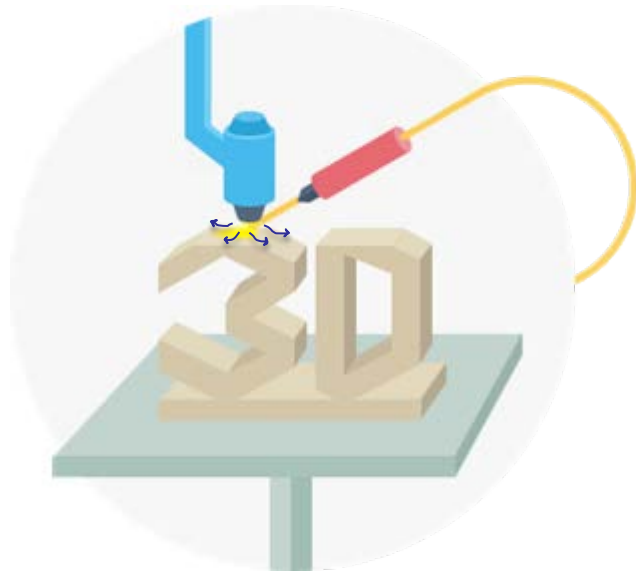
50 g/min



80 g/min

[1] Influence of Process Parameters in the Direct Metal Deposition of H13 Tool Steel on Copper Alloy Substrate, Imran et al., Proceedings of the World Congress on Engineering Vol III, 2010

[2] Used with permission from DMG Mori



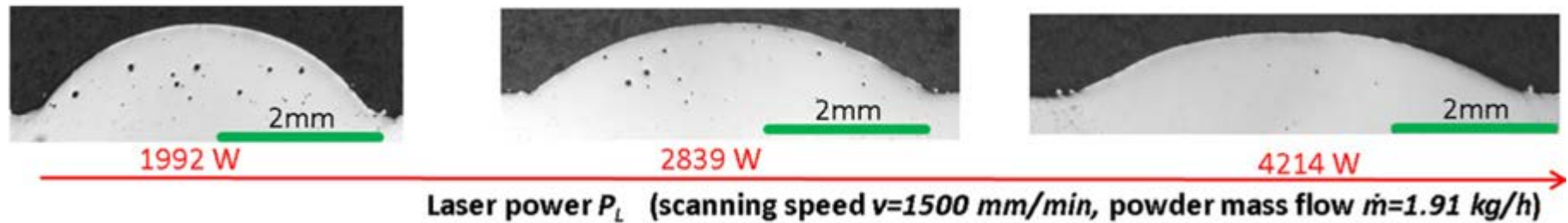
Effect of Shield Gas Flow on 8620 Steel Build Quality

Sufficient
Shield Gas Flow

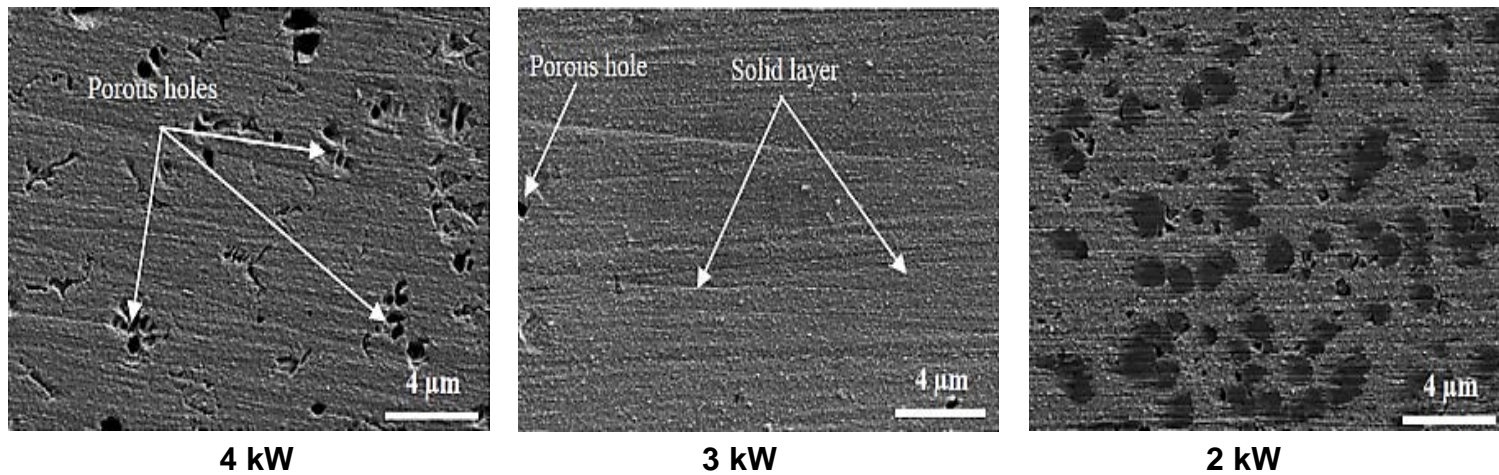


Insufficient
Shield Gas Flow





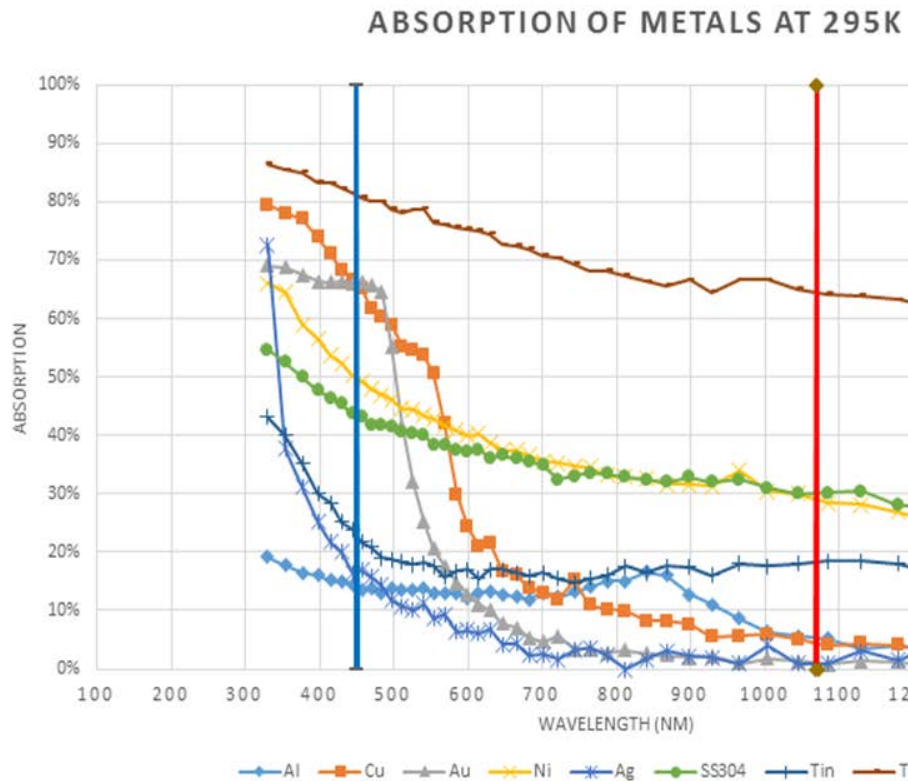
[1]



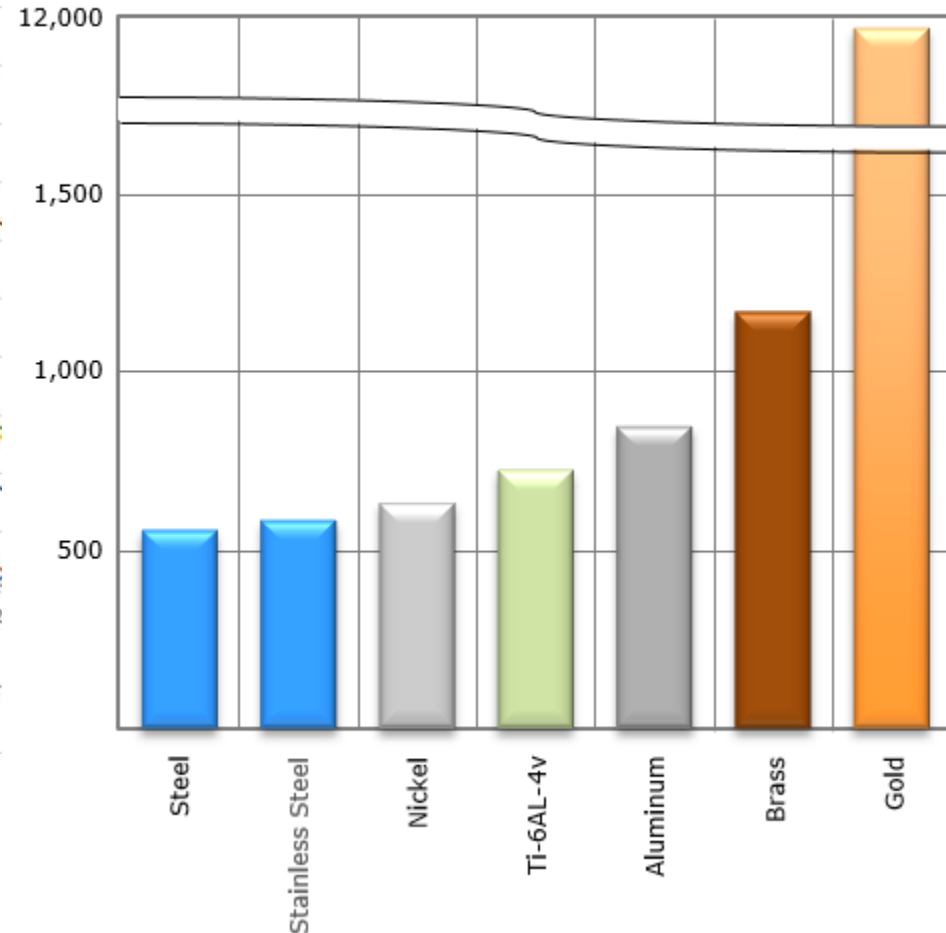
[2]

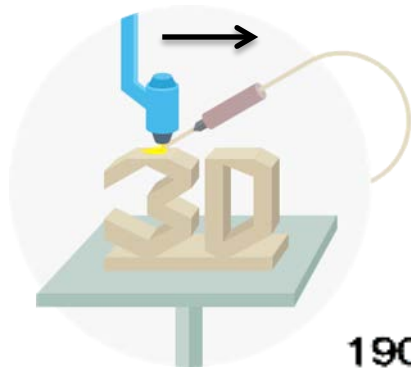
[1] Experimental study of effects of main process parameters on porosity, track geometry, deposition rate, and powder efficiency for high deposition rate laser metal deposition, Zhong et al., *Journal of Laser Applications*, 2015

[2] Influence of Process Parameters in the Direct Metal Deposition of H13 Tool Steel on Copper Alloy Substrate, Imran, *Proceedings of the World Congress on Engineering*, 2010

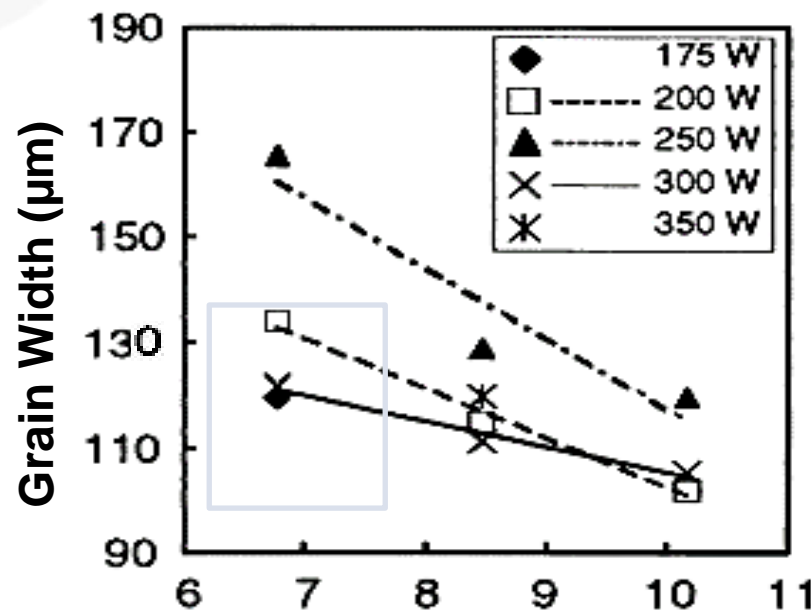
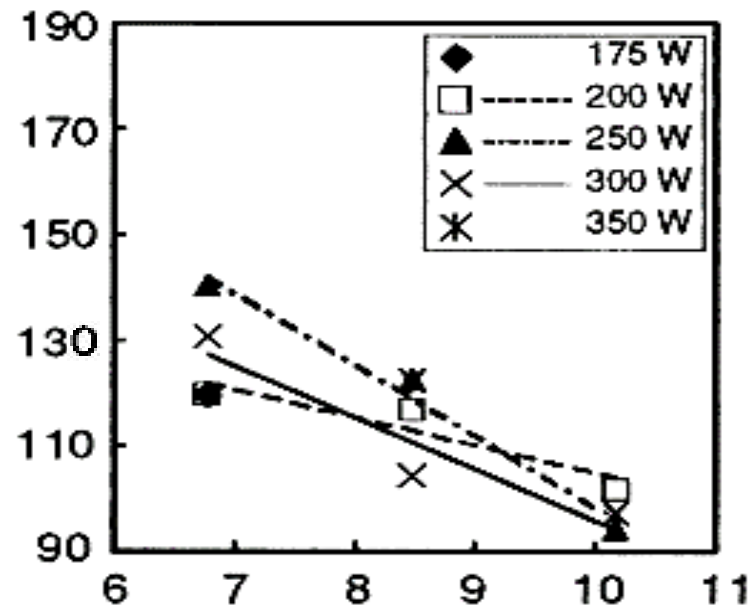


NUBURU laser speed advantage* versus IR fiber laser in %

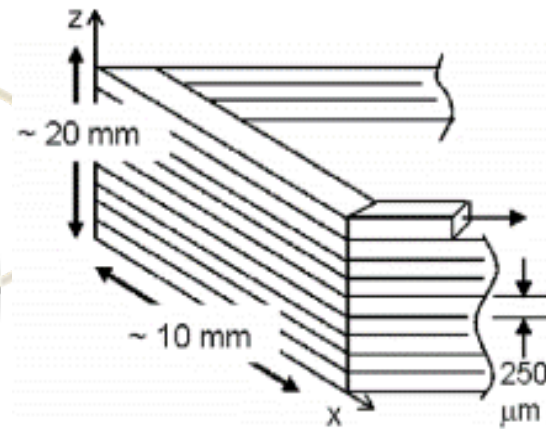
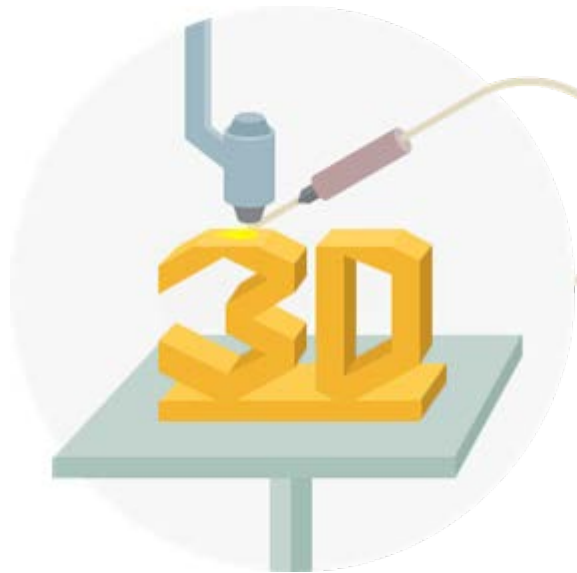
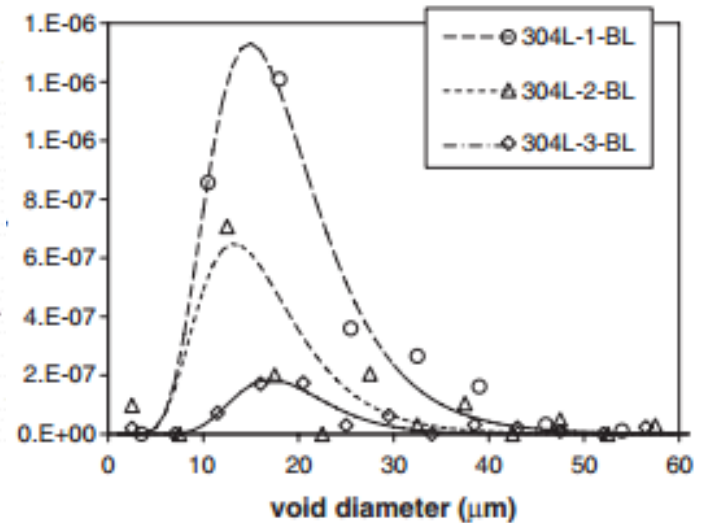




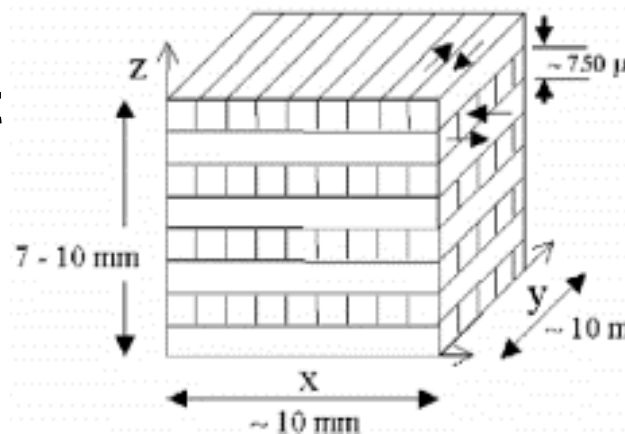
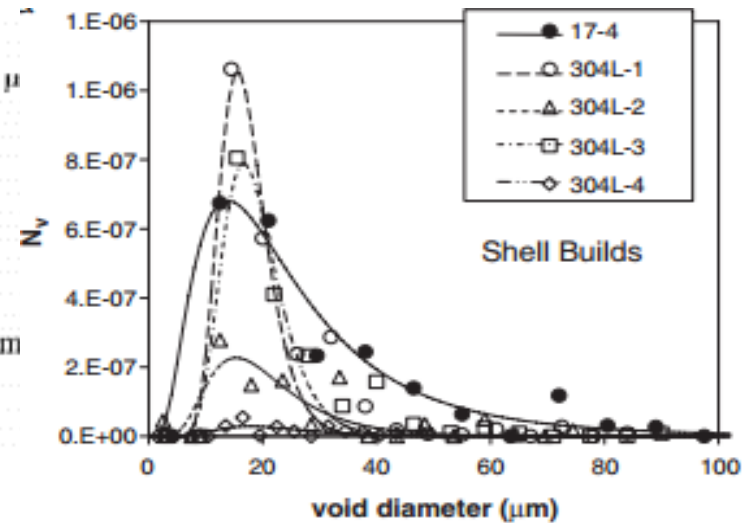
Effect of Scan Speed and Laser Power on Ti-6Al-4V Build Microstructure

Thin substrate**Thick substrate**

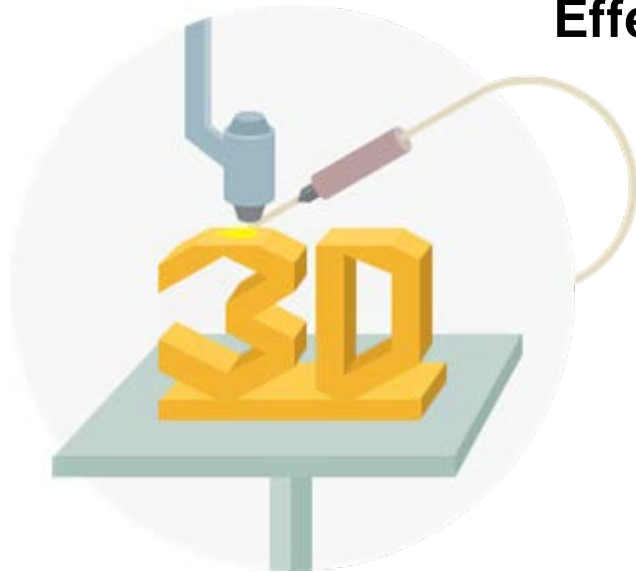
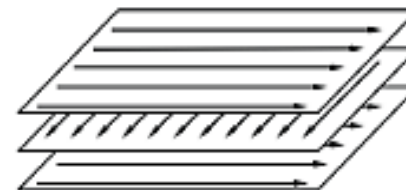
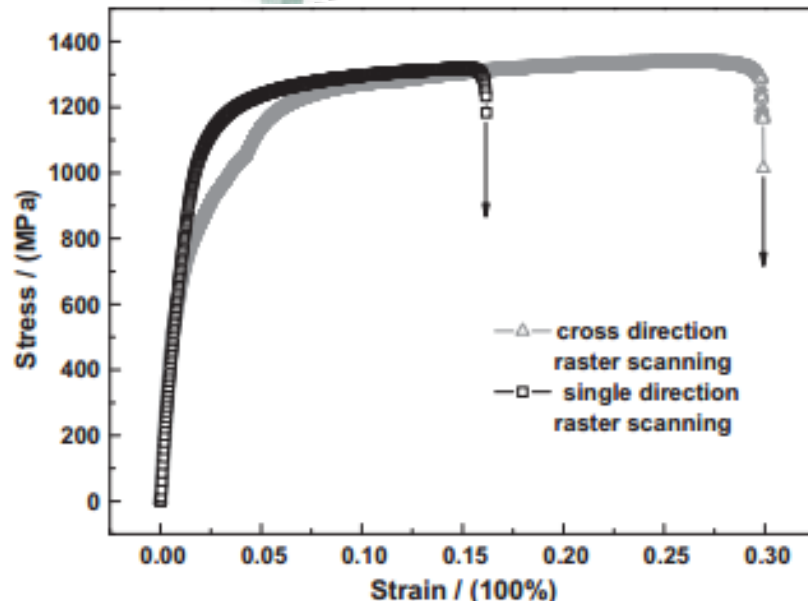
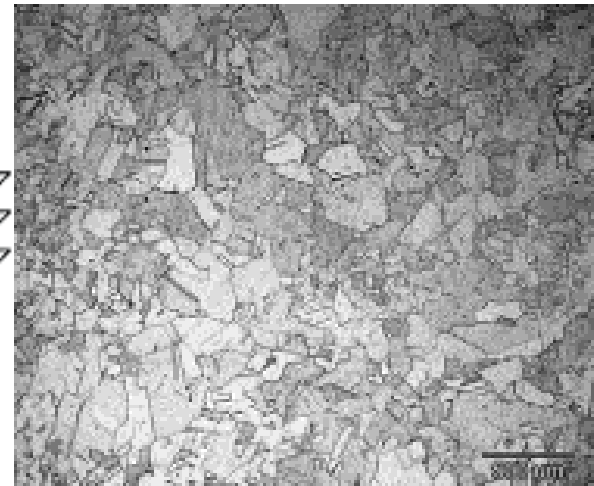
Traverse Speed (mm/s)

**Shell Build 304L SS**

Effect of Part Geometry on Porosity

**Block Build 304L SS**

Effect of Deposition Direction on Microstructure

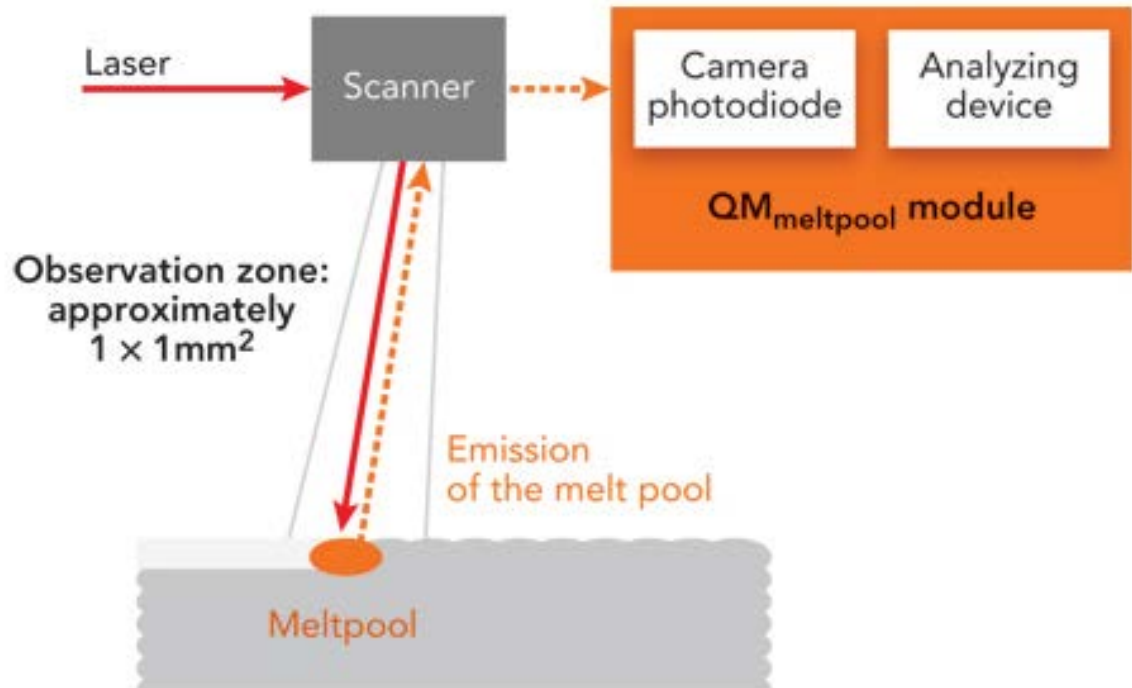
**Single Direction Scanning****Cross Direction Scanning**

- Overview of **DED** and Electrospinning
- Process Parameters and Their Influences
- **Sensing and Characterization Methods**
- Process Control
- Research Needs



Approaches

- Imaging
 - Infrared (IR) and visible-wavelength cameras
- Emission detection
 - Variations of optical pyrometry or spectroscopy





Methods

- Electronic scale: change of weight of metal powders in the hopper
- Optoelectronic sensor: laser energy decreased with increasing powder delivery rate

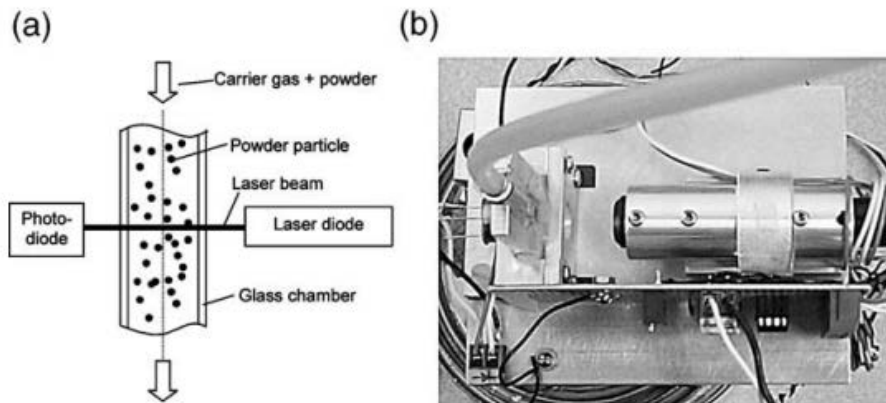


Fig. 1. Powder delivery rate sensor. (a) Schematic of the powder delivery rate sensor. (b) Setup of the powder delivery rate sensor.

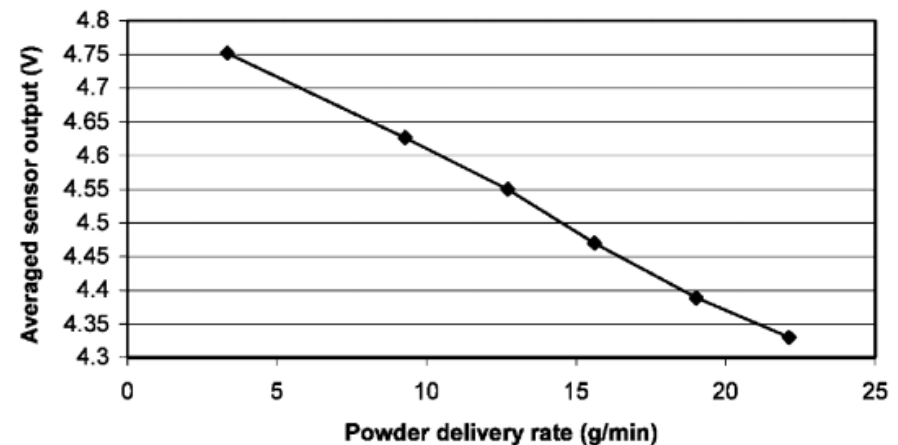
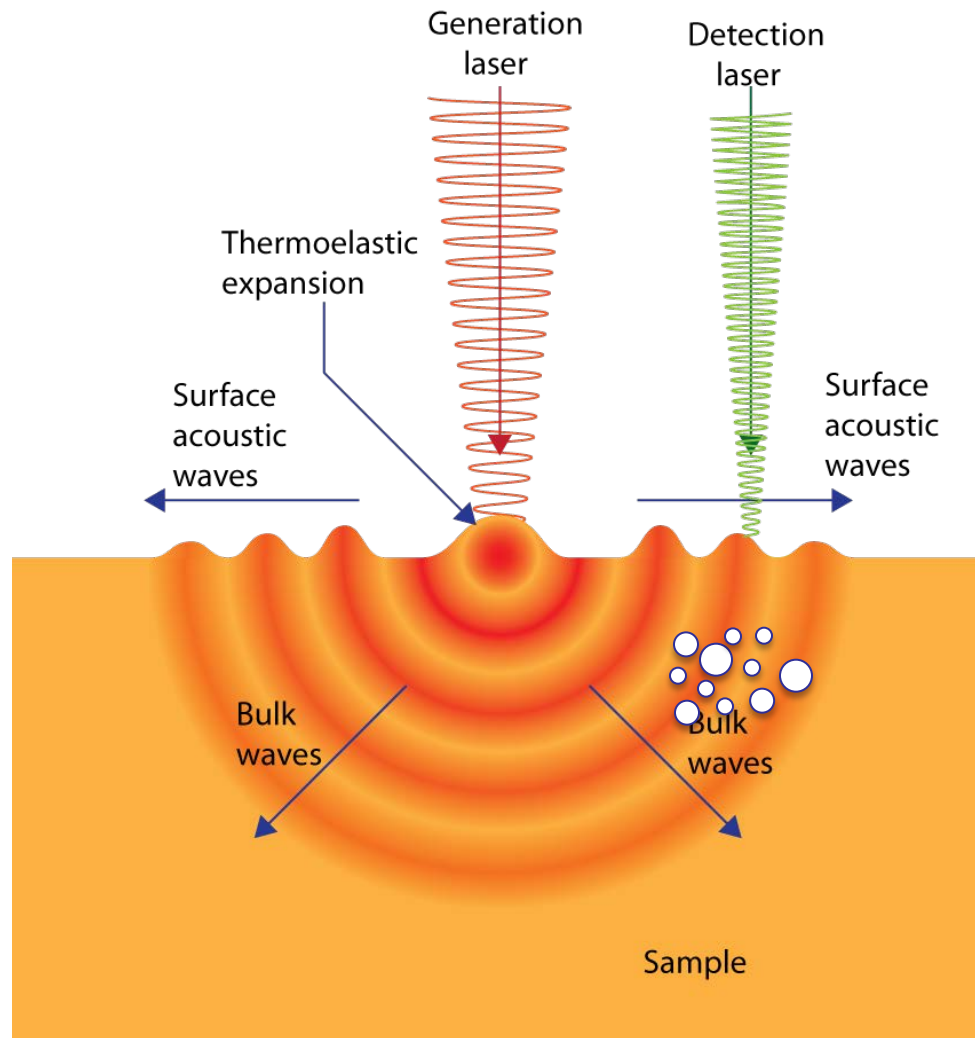
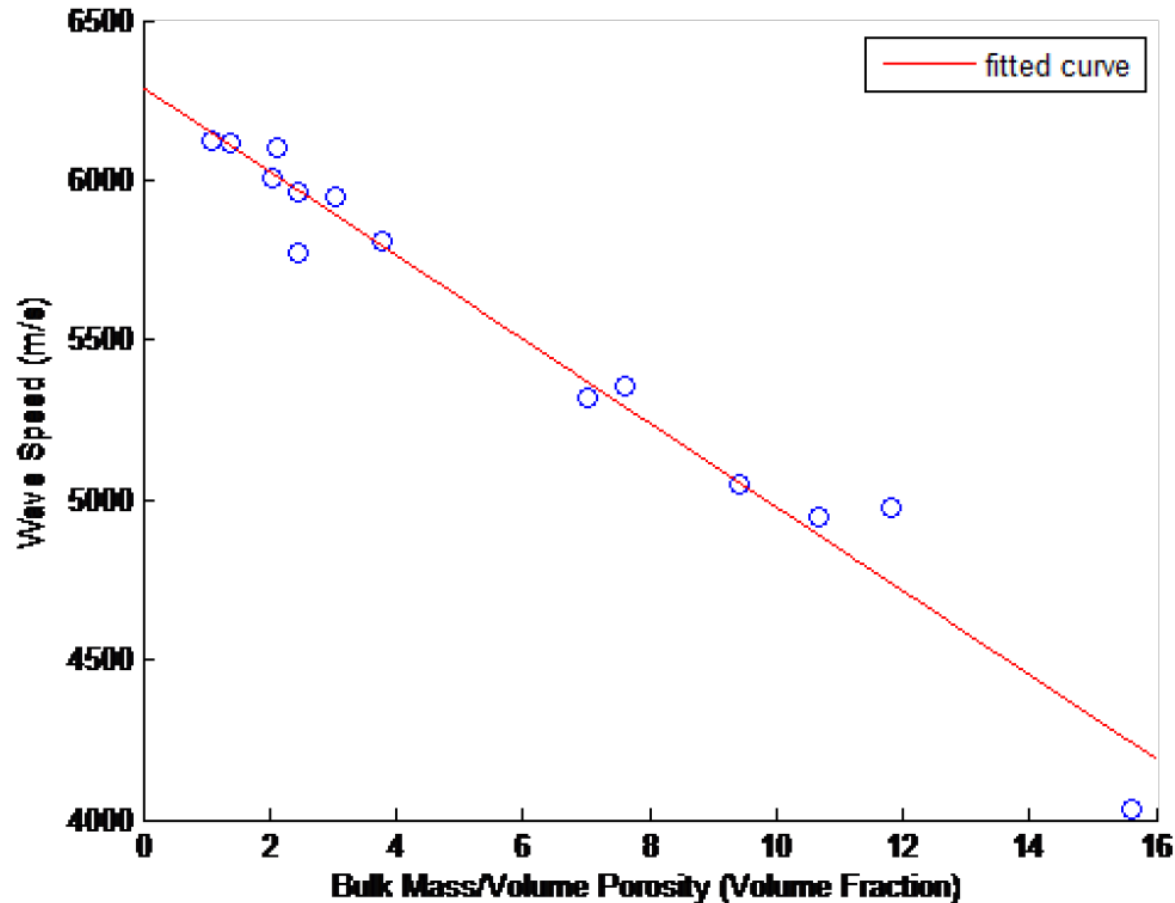


Fig. 2. Output performance of the powder delivery rate sensor.



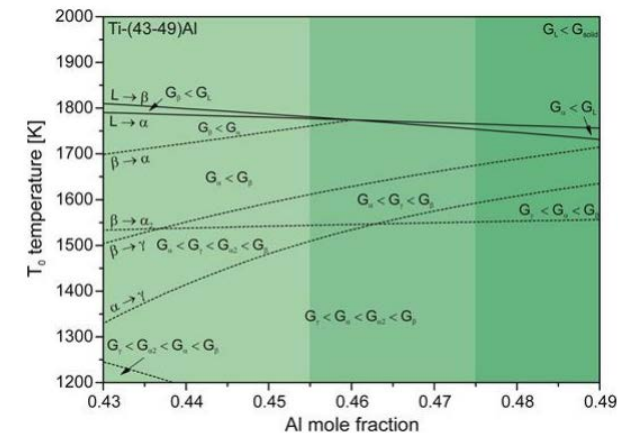
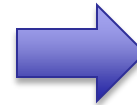


Bulk Ultrasonic Wave Speed Variation with Porosity in LENS[®] Manufactured CoCr Sample

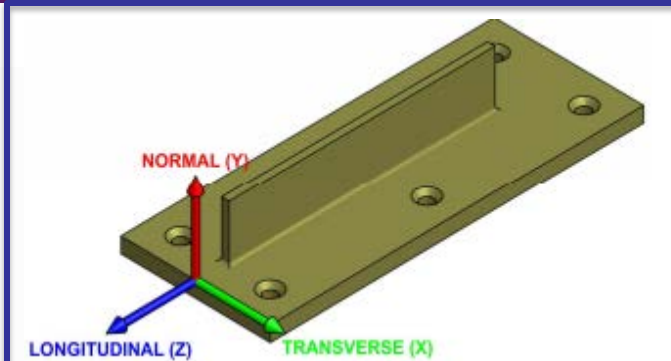
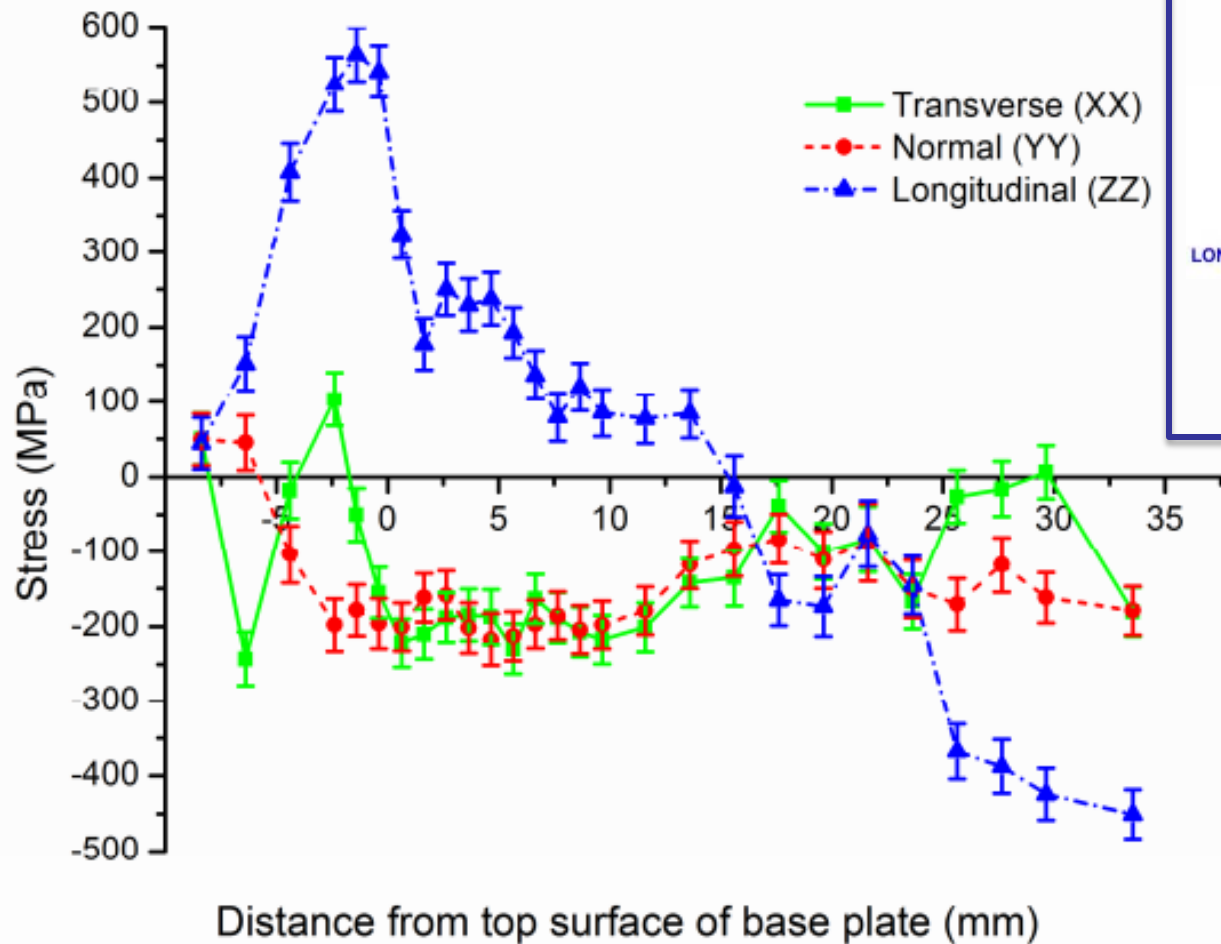


J.A. Slotwinski, E.J. Garboczi, and K.M. Hebenstreit, "Porosity Measurements and Analysis for Metal Additive Manufacturing Process Control," *Journal of Research of the NIST* **119**, pp. 494-528, (2014).

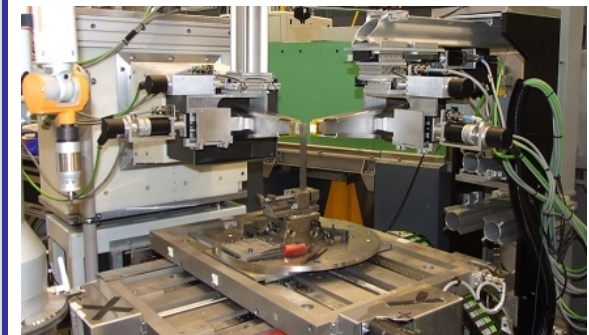
and cooled Ti alloys



Leinenbach, C., LANL Workshop, Santa Fe, 20/21.07.2015



Thin-walled component built on base plate

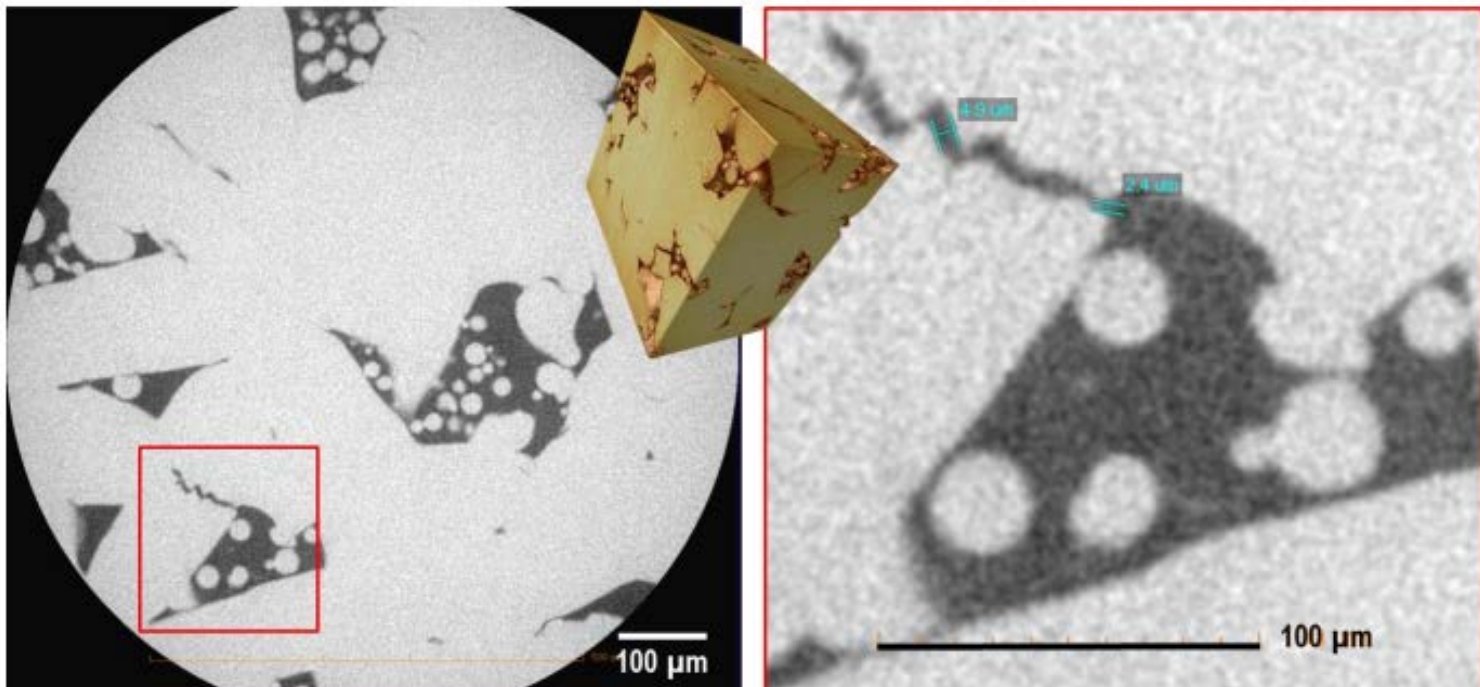


KOWARI strain scanner using neutron diffraction

Hoye, N., et al. (2014). Measurement of residual stresses in titanium, aerospace components formed via additive manufacturing. Material Science Forum.



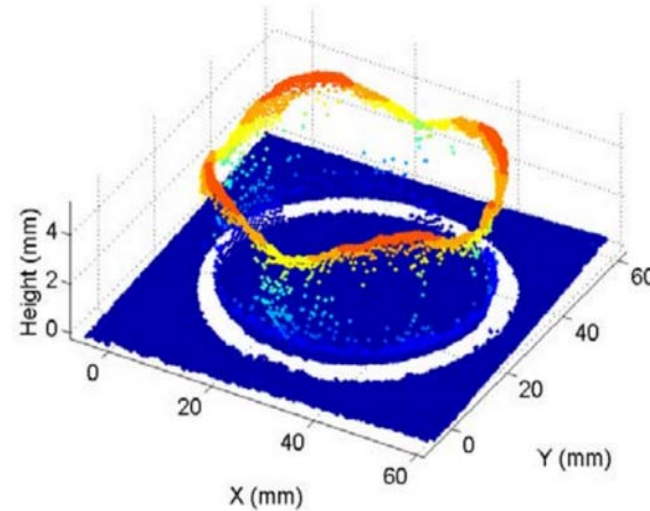
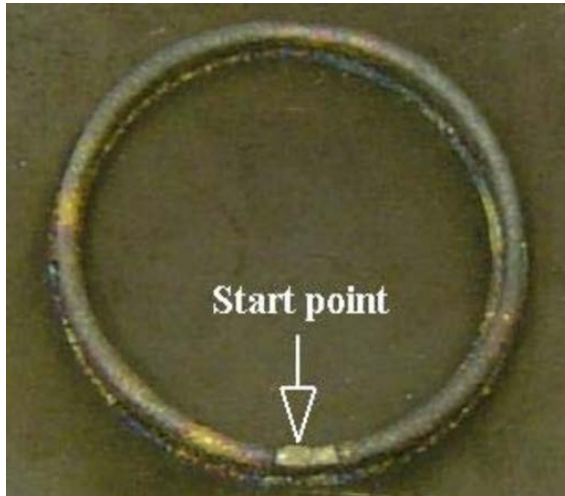
Novel submicron X-ray microscopy for sub-surface imaging and reveals 3D microstruture



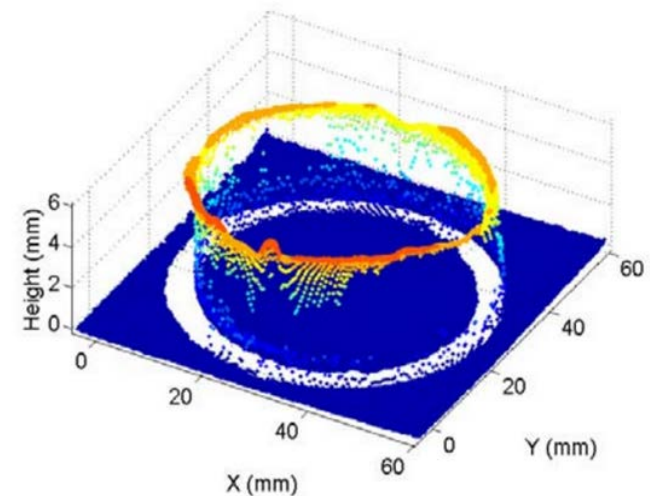
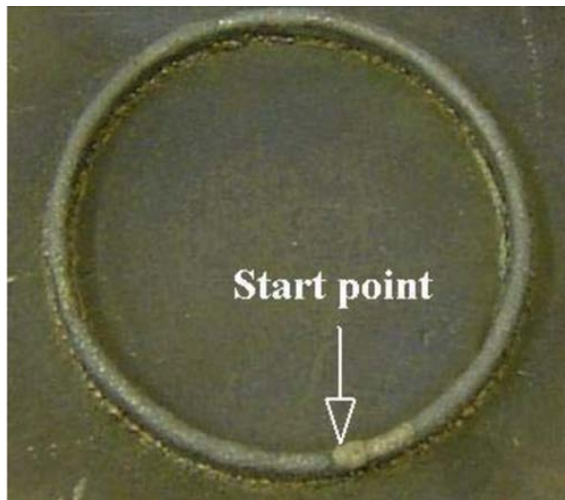
- Overview of **DED** and Electrospinning
- Process Parameters and Their Influences
- Sensing and Characterization Methods
- **Process Control**
- Research Needs

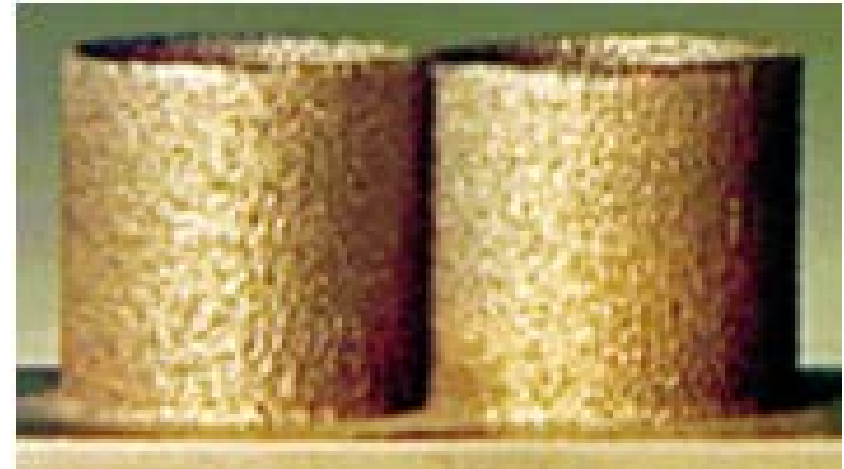
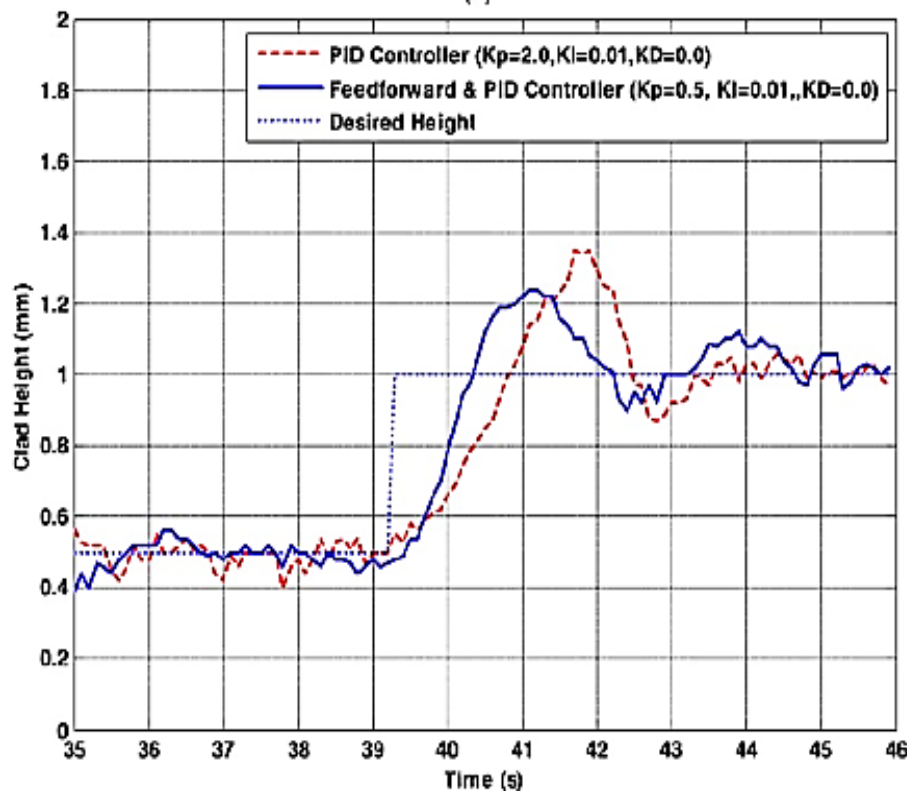


Without Control

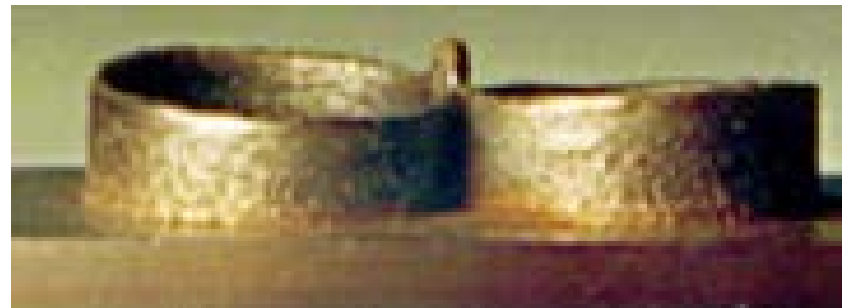


With Control





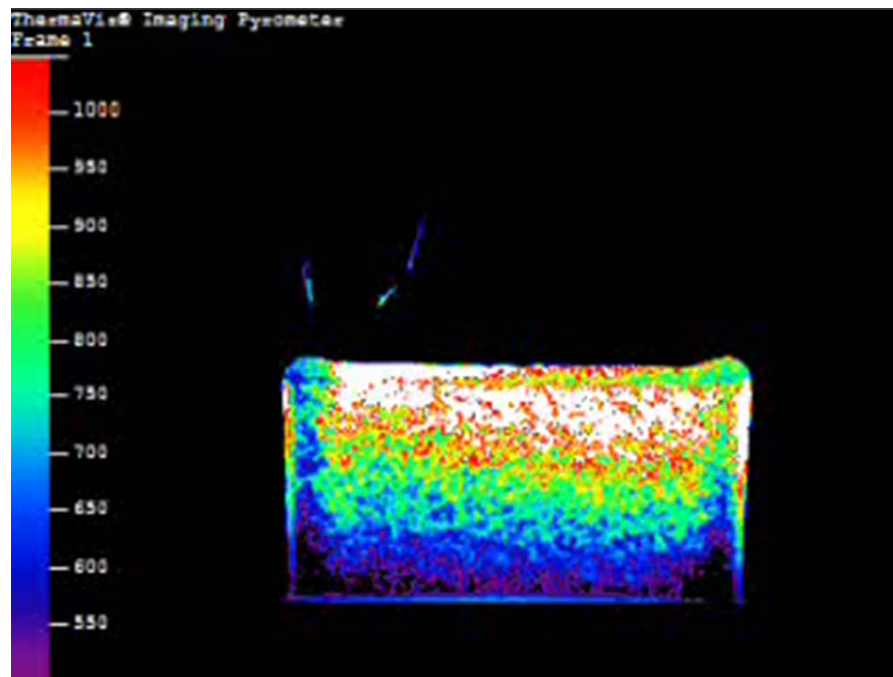
With Control



Without Control

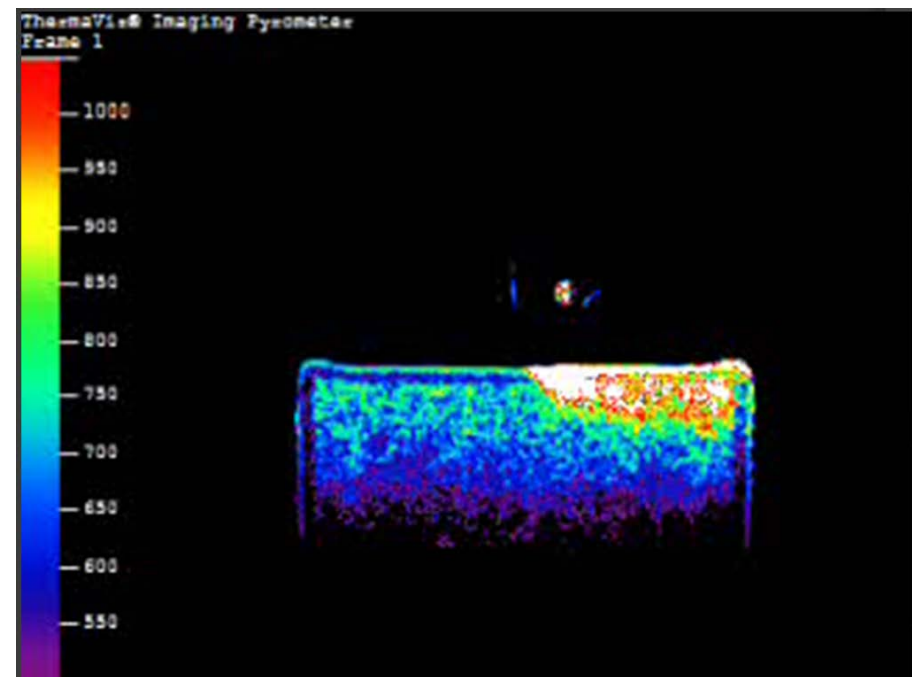


Without Control



Deposit experiences increased heating during build

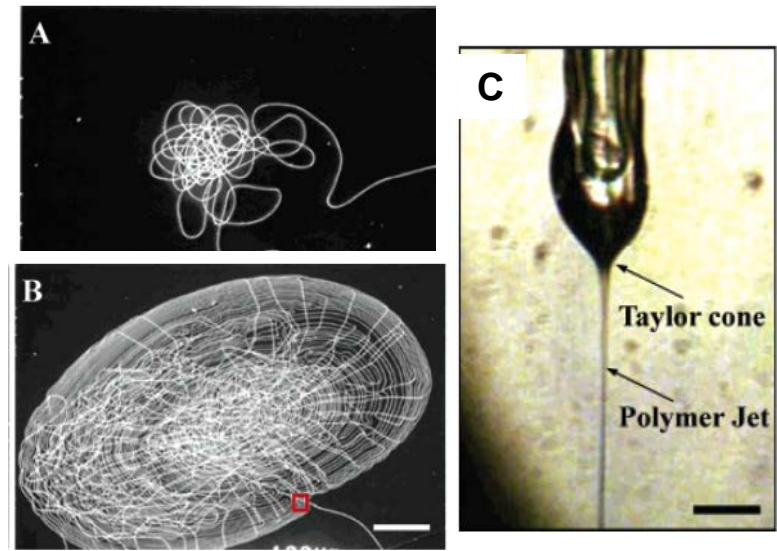
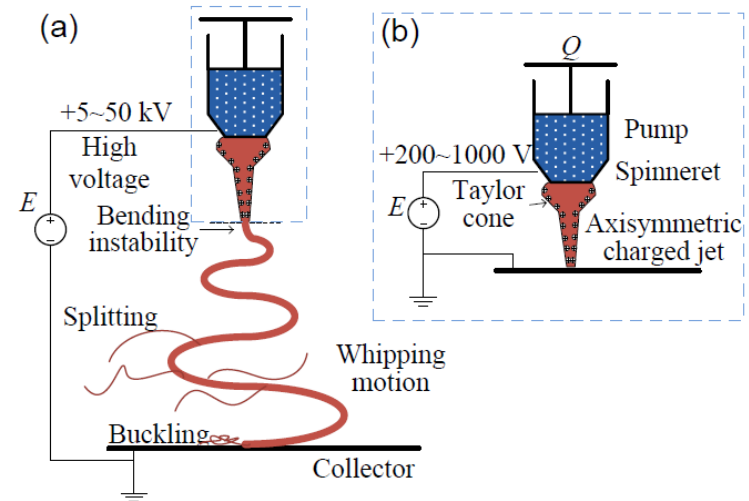
With Control



Deposit experiences stable heating at reduced levels

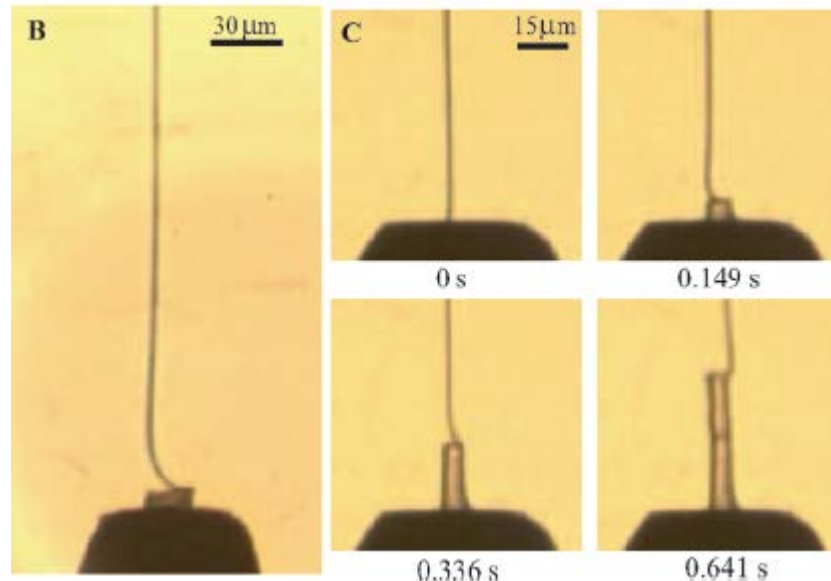
- Overview of DED and **Electrospinning**
- Process Parameters and Their Influences
- Sensing and Characterization Methods
- Process Control
- Research Needs

- Near Field Electrospinning takes a random deposition process and converts it into a controlled additive manufacturing process.
- Unique in-situ monitoring requirements due to printing via continuous nano and micro fiber deposition.
- System typically operates using open loop control.
- Metrology and characterization done after deposition via SEM.



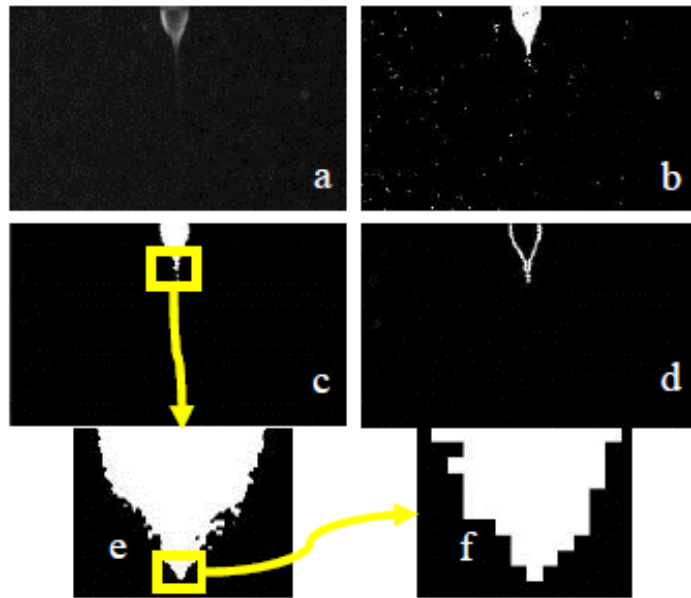
(A) Deposition of single fiber, scale bar: 100 μm (B) structure deposition, scale bar: 100 μm (C) Microscopic image of deposition process, scale bar: 25 μm

- **Process parameters:** electric field strength, flow rate, deposition speed, and evaporation rate.
- On line **diagnostic requires** high magnification and high temporal resolution of deposition process over large areas.
 - Fiber diameters range from ~ 5 nm to tens of microns.
 - Collector speeds up to 100s of millimeters per second
 - Areas of tens of centimeters.
- **Monitoring of fiber** in flight: diameter, speed, orientation

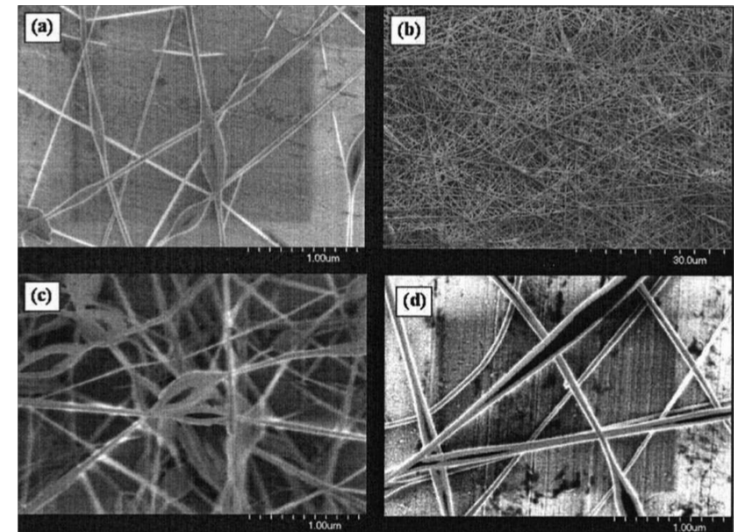
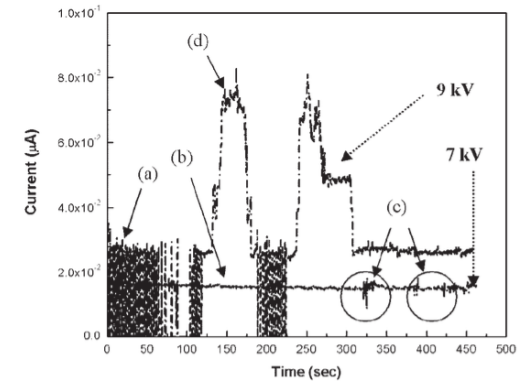


Kim, Ho-Young, et al. "Nanopottery: coiling of electrospun polymer nanofibers." *Nano letters* 10.6 (2010): 2138-2140.
Huang, Zheng-Ming, et al. "A review on polymer nanofibers by electrospinning and their applications in nanocomposites." *Composites science and technology* 63.15 (2003): 2223-2253.

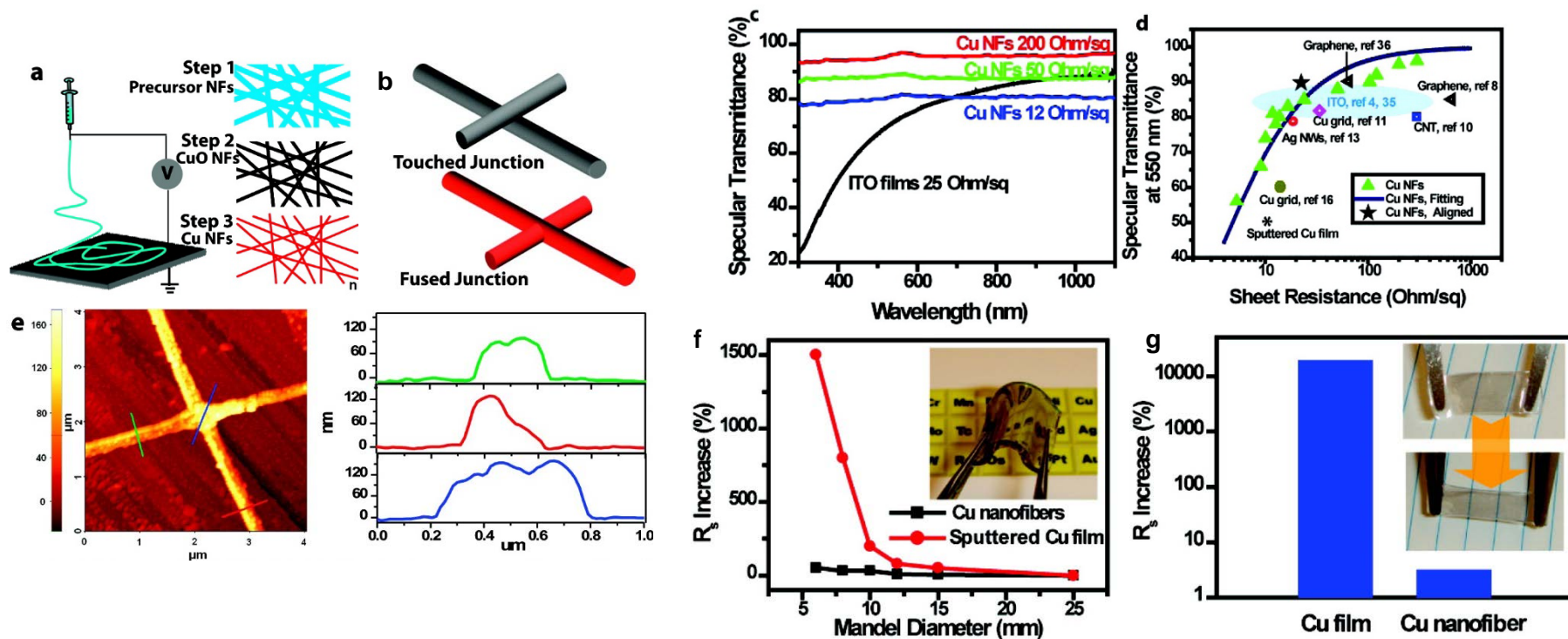
- Current in-situ sensing limited to environmental control (humidity, temperature), electrical current, and limited optical feedback.



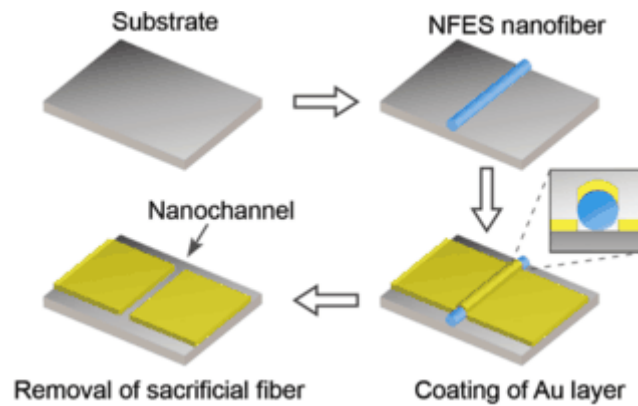
Real-time optical monitoring of Taylor cone to assure continuous deposition and estimate fiber diameter.



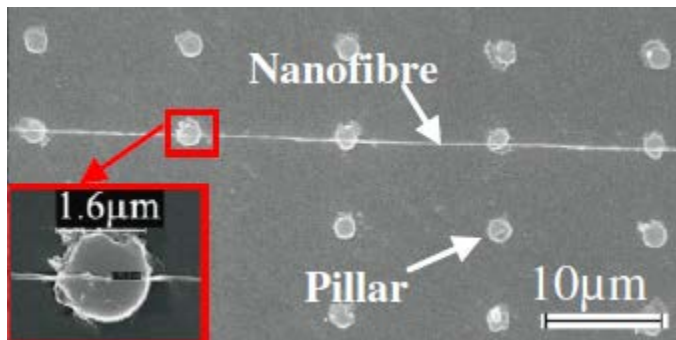
Relation between electric current and fiber morphology



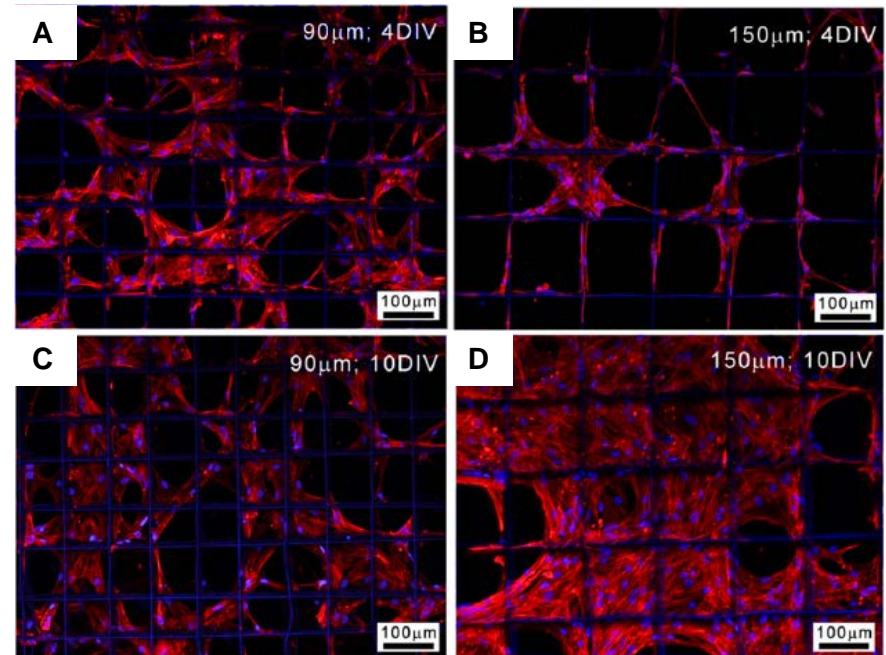
- Production of copper nanofiber webs via two-step pyrolysis of PVA and copper acetate webs deposited by electrospinning.
- High fiber density leads to resistance reduction
- High transparency and conductivity.



Printing of nano and microchannels

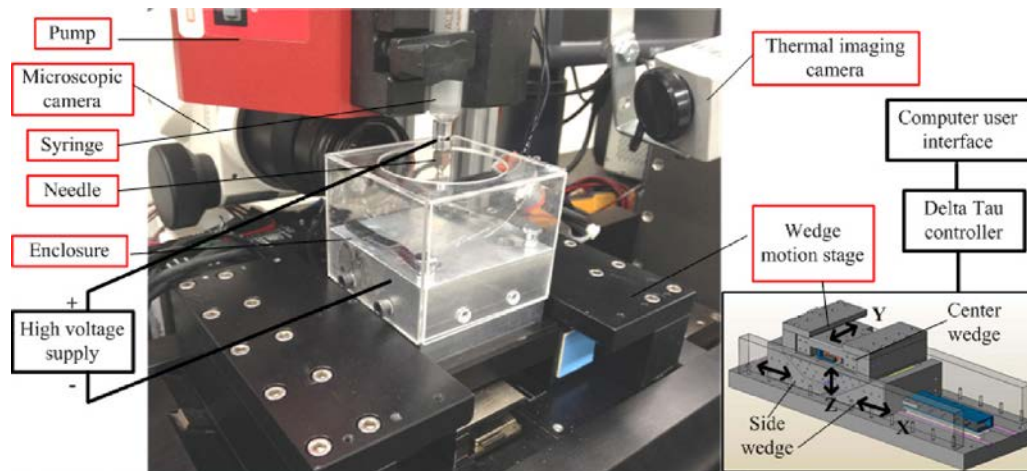


Deposition of nanofibers on patterned silicon collector

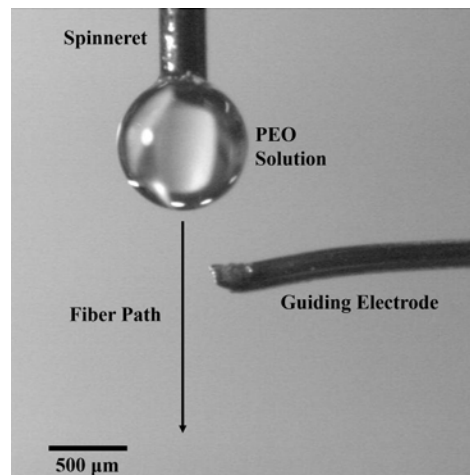
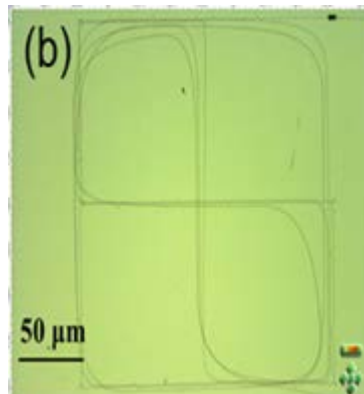


Cell Scaffolds with excellent spacing control printed via near field melt electrospinning

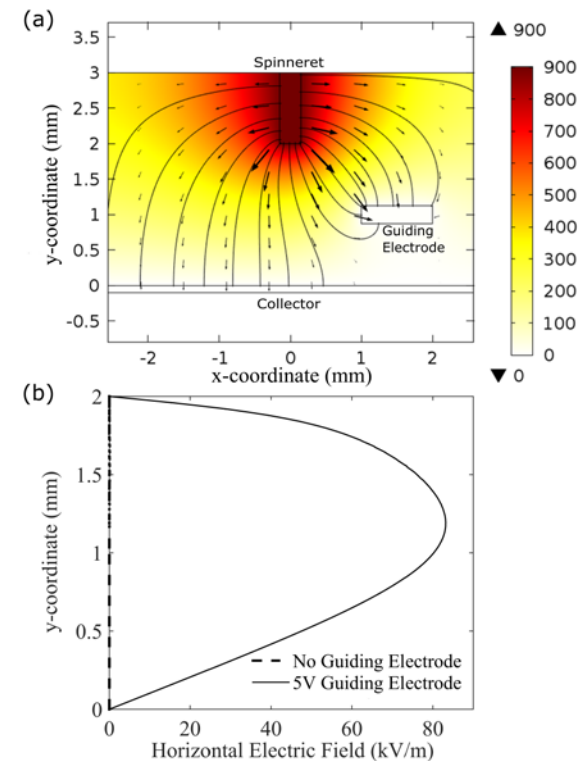
- Wang, Xiang, et al. "Fabrication of nanochannels via near-field electrospinning." *Applied Physics A* 108.4 (2012): 825-828.
- Zheng, Gaofeng, et al. "Precision deposition of a nanofibre by near-field electrospinning." *Journal Of Physics. D. Applied Physics* 43.41 (2010): 415501.
- Hochleitner, Gernot, et al. "Additive manufacturing of scaffolds with sub-micron filaments via melt electrospinning writing." *Biofabrication* 7.3 (2015): 035002.



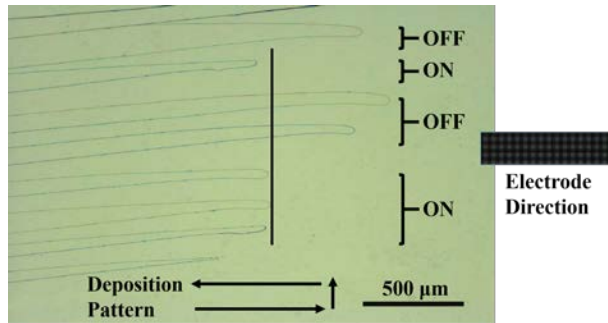
NFES Setup



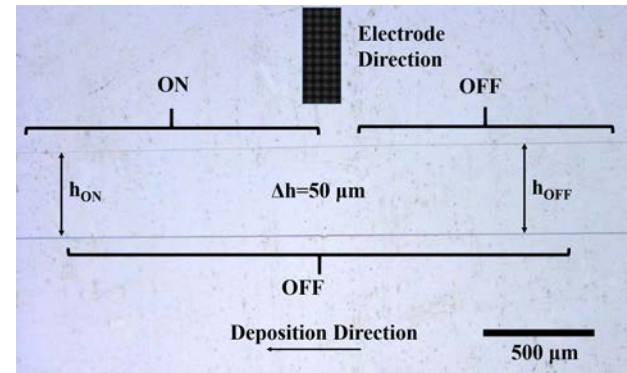
Guiding electrode as used



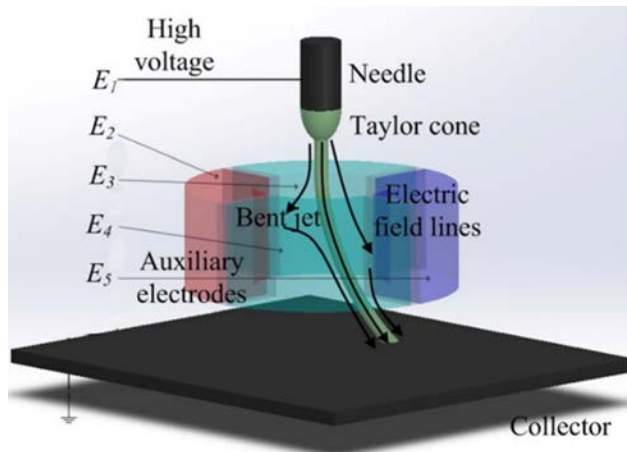
(a) Electric field simulation: electric potential contours, electric field streamlines, and electric field arrows. (b) Comparison of the horizontal component of the electric field along the central axis when the guiding electrode is not present and when a 5 V potential is applied to it



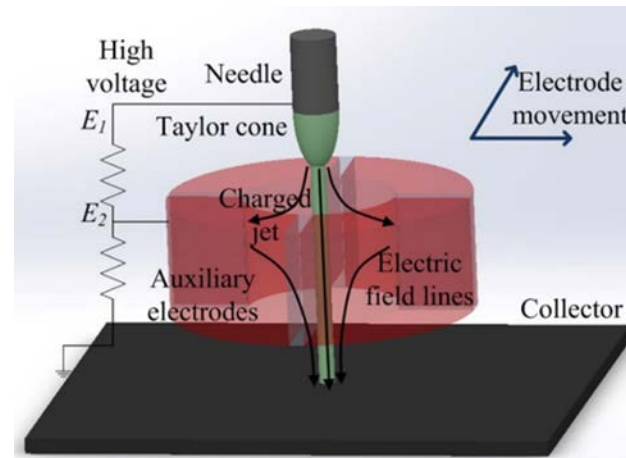
Results show increased repeatability in deposition when secondary electrode is used.



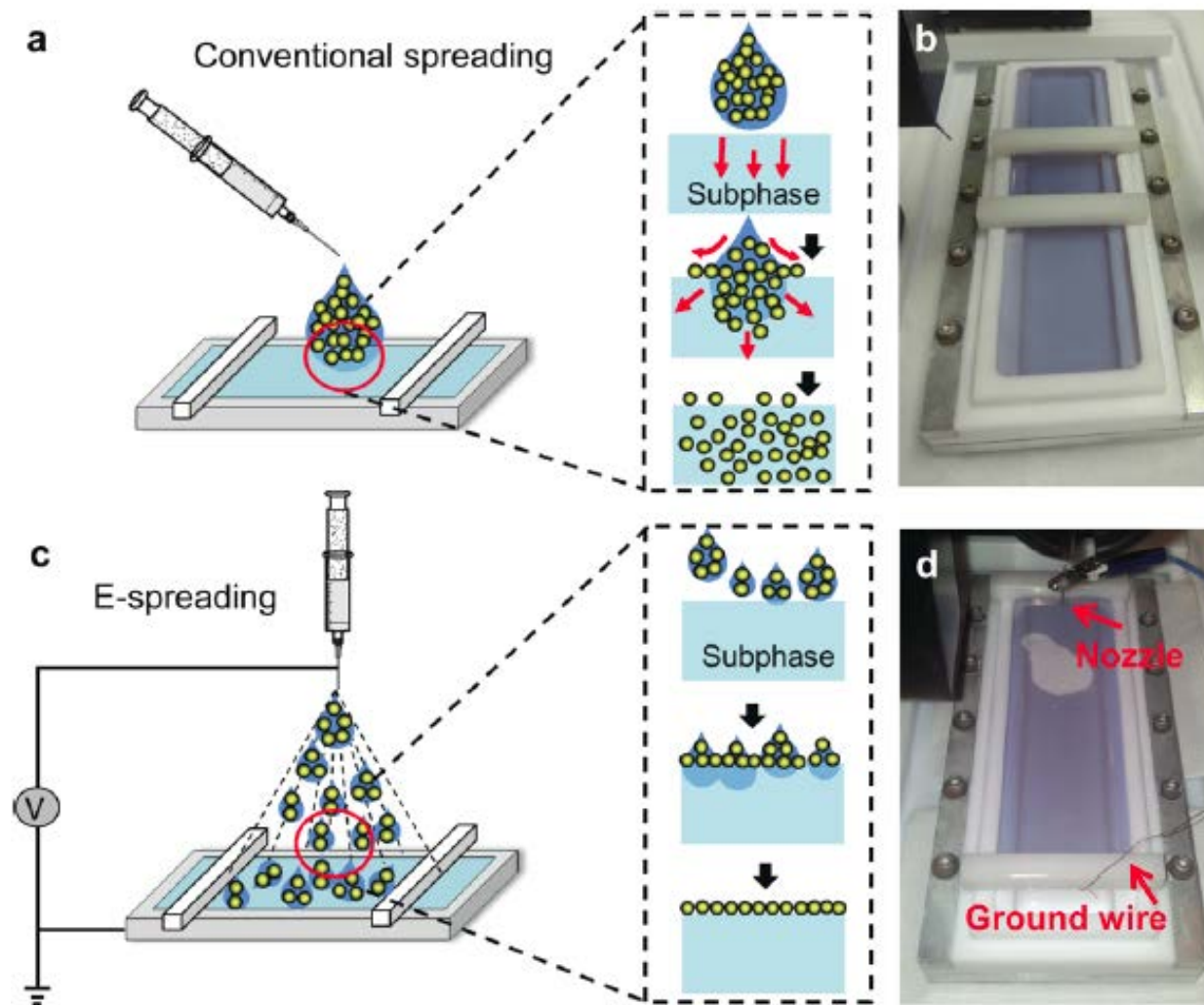
Results show increased fiber deposition control when secondary electrode is used.



Proposed stationary electrode ring design with four independent potentials.



Proposed piezo actuated electrode ring design at a single potential.



- **Overview of DED and Electrospinning**
- **Process Parameters and Their Influences**
- **Sensing and Characterization Methods**
- **Process Control**
- **Research Needs**

* Given that AM enables the realization of both design geometry and multi-material characteristics, how do we develop digitally compatible computational design tools that **address** and **integrate** multi-material and geometric information into the design of manufacturing process considering **uncertainties**?

Local non-equilibrium solution

- Porosity
- Grain size
- Orientation
- Phase %
- Residual Stress

Simulation Driven

Mechanical

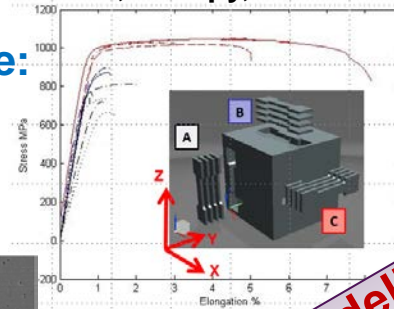
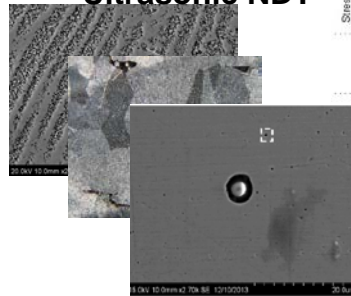
Properties: Tensile, Shear, Charpy, etc.

Topological Design

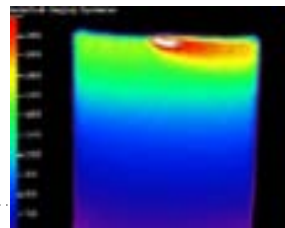


Microstructure:

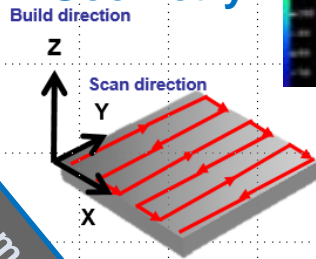
SEM, TEM, FIB,
Ultrasonic NDT



Thermal History: IR Camera



Tool Path and Build Geometry



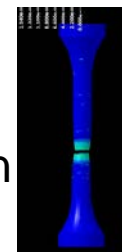
Preprocessing and Calibration

Process Parameters

Process Design

Image/Process-Based Constitutive Modeling

Property Prediction

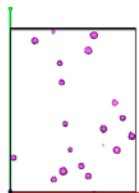
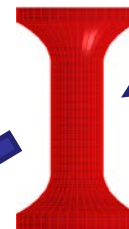


FEA Mesh

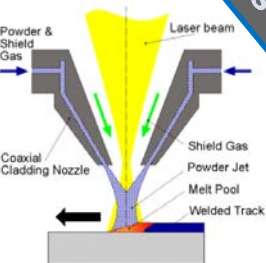
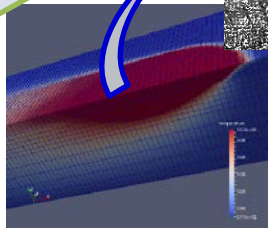
Microstructure Reconstruction

Preprocessing and Calibration

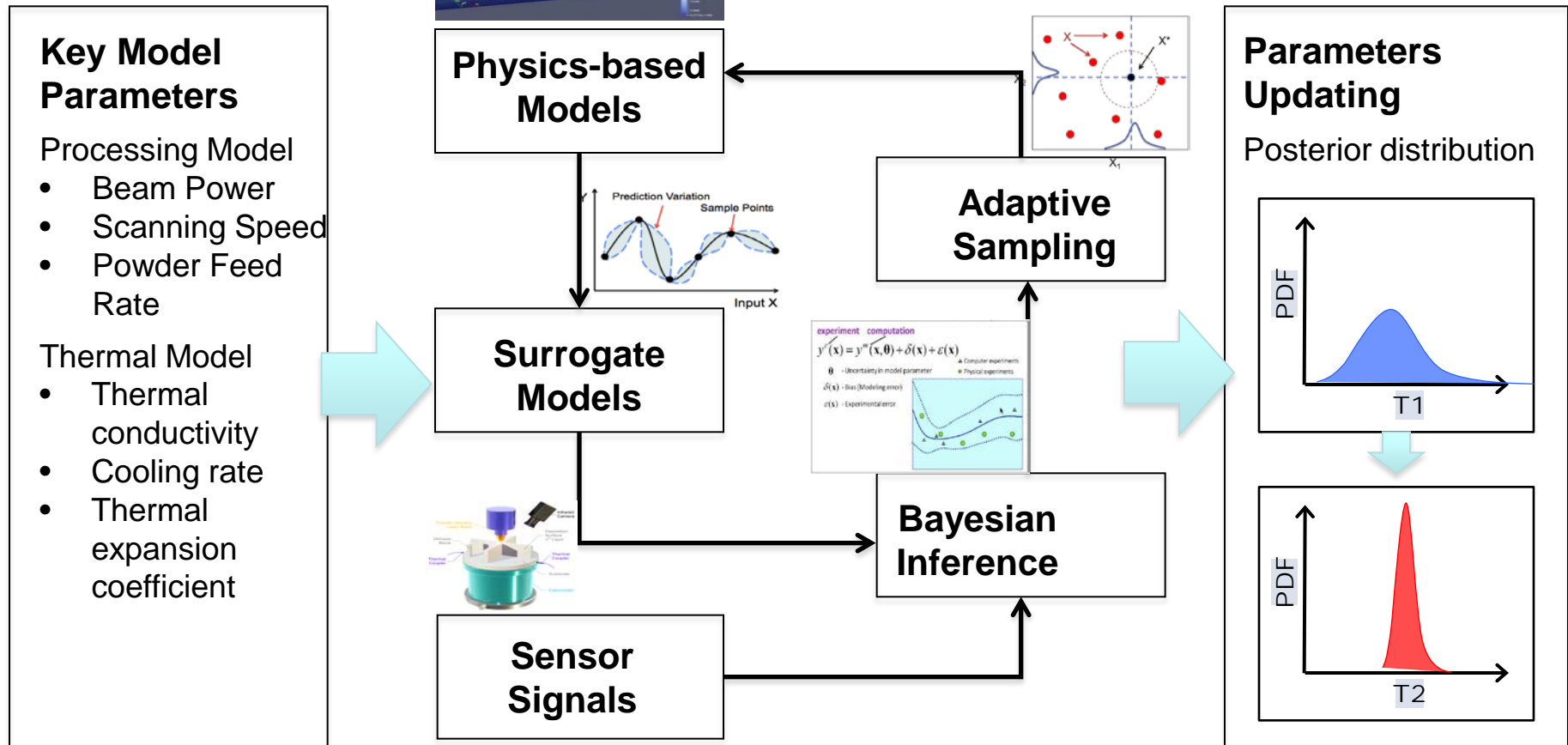
Mechanical Modeling

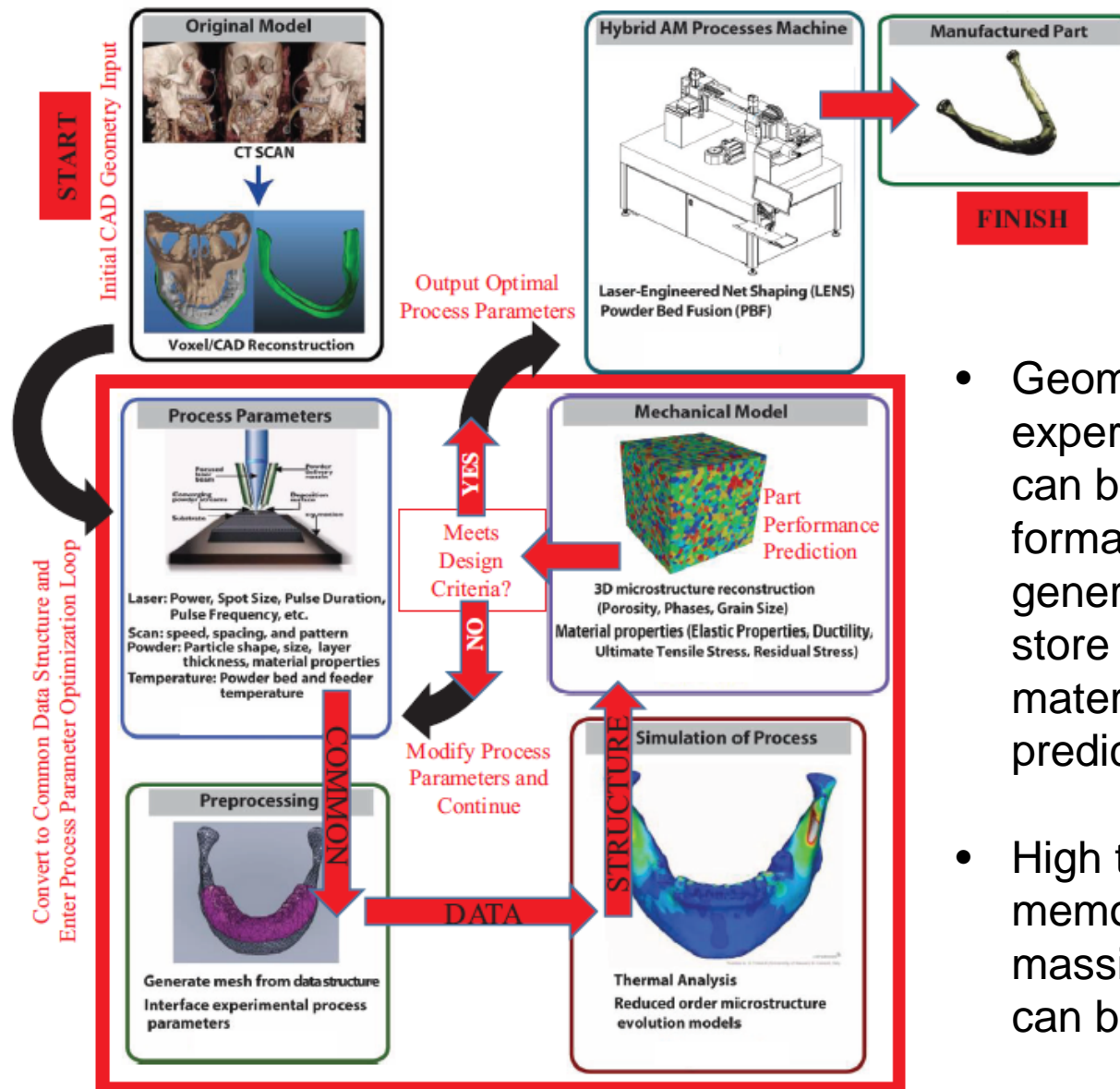


Thermal Modeling



Identify key unknown parameters in the material model

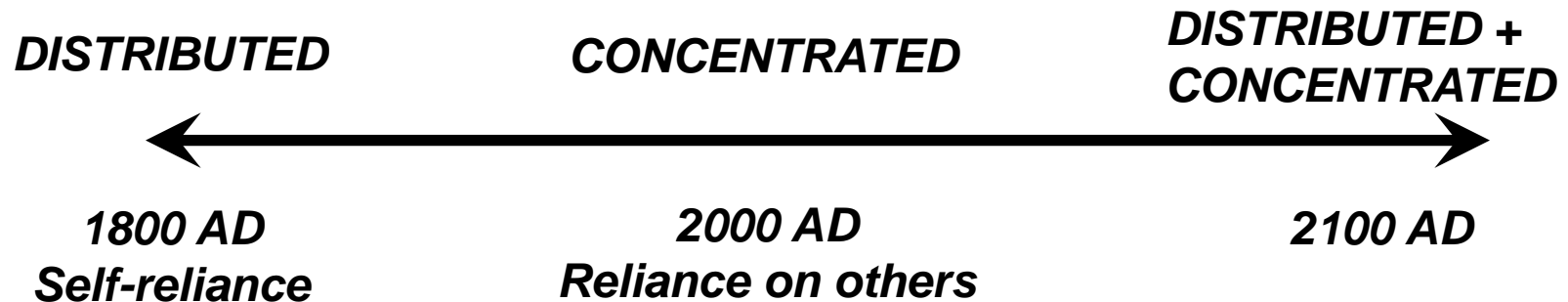




- Geometric and experimental information can be saved in a compact format which is used to the generate simulation mesh, store simulation results and material performance prediction.
- High throughput and memory bandwidth of massively parallel GPUs can be leveraged.

* Given that AM enables the realization of both design geometry and multi-material characteristics, how do we develop digitally compatible computational design tools that **address** and **integrate** multi-material and geometric information into the design of manufacturing process considering **uncertainties**?

* Many of the limitations of AM can be effectively addressed with **predictive simulation** paired with **equipment innovation**, effective **process control** and a strong understanding of the processes, materials, and properties involved.



CURRENT FORCES NOW AT WORK

- Globalization
- Cyber Infrastructure
- Technological Advances
- Mass Customization / Personalization
- Emergence of Point-of-use Technologies



Support from NIST, NSF, DOD and DMG MORI

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THANK YOU

